HPM-ERSDE

Dual 4th/5th Generation Intel®Xeon® Scalable Processor Proprietary Server Board with Intel®C741 Chipset and IPMI2.0. Processor supports up to 270W TDP

User's Manual

2nd Ed – 13 November 2025

Copyright Notice

Copyright © 2025 Avalue Technology Inc., ALL RIGHTS RESERVED.

Part No: E2047P4S101R

Document Amendment History

Revision	Date	Ву	Comment
1 st	March 2024	Avalue	Initial Release
2 nd	November 2025	Avalue	Update 2.3 Setting Jumpers & Connectors

Declaration of Conformity



This device complies with part 15 fcc rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference.
- (2) This device must accept any interference received including interference that may cause undesired operation.

This equipment has been tested and found to comply with the limits for a class "a" digital device, pursuant to part 15 of the fcc rules.

These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications.

Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

CE statement

The product(s) described in this manual complies with all application European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.

Notice

This guide is designed for experienced users to setup the system within the shortest time. For detailed information, please always refer to the electronic user's manual.

Copyright Notice

© 2025 by Avalue Technology Inc. All rights are reserved. No parts of this manual may be copied, modified, or reproduced in any form or by any means for commercial use without the prior written permission of Avalue Technology Inc. All information and specification provided in this manual are for reference only and remain subject to change without prior notice.

Acknowledgements

Intel and Pentium are trademarks of Intel Corporation.

Microsoft Windows is registered trademark of Microsoft Corp.

All other product names or trademarks are properties of their respective owners.

Disclaimer

This manual is intended to be used as a practical and informative guide only and is subject to change without notice. It does not represent a commitment on the part of Avalue. This

product might include unintentional technical or typographical errors. Changes are periodically made to the information herein to correct such errors, and these changes are incorporated into new editions of the publication.

A Message to the Customer

Avalue Customer Services

Each and every Avalue's product is built to the most exacting specifications to ensure reliable performance in the harsh and demanding conditions typical of industrial environments. Whether your new Avalue device is destined for the laboratory or the factory floor, you can be assured that your product will provide the reliability and ease of operation for which the name Avalue has come to be known.

Your satisfaction is our primary concern. Here is a guide to Avalue's customer services. To ensure you get the full benefit of our services, please follow the instructions below carefully.

Technical Support and Assistance

- 1. Visit the Avalue website at https://www.avalue.com/ where you can find the latest information about the product.
- 2. Contact your distributor or our technical support team or sales representative for technical support if you need additional assistance. Please have following information ready before you call:
- Product name and serial number
- Description of your peripheral attachments
- Description of your software (operating system, version, application software, etc.)
- A complete description of the problem
- The exact wording of any error messages

To receive the latest version of the user's manual; please visit our Web site at: www.avalue.com

Product Warranty (Returns & Warranties policy)

1. Purpose

Avalue establishes the following maintenance specifications and operation procedures for providing the best quality of service and shortened repair time to our customers.

2. Warranty

2.1 Warranty Period

Avalue endeavors to offer customers the most comprehensive post-sales services and protection; besides offering a 2-year warranty for standard Avalue products, an extended warranty service can also be provided based on additional request from the customer. Within the warranty period, customers are entitled to receive comprehensive and prompt repair and warranty.

Standard products manufactured by Avalue are offered a 2-year warranty, from the date of delivery from Avalue. For ODM/OEM products manufactured by Avalue or PCBA with conformal coating, will follow up the define warranty of the agreement, otherwise will be offered 1-year warranty for ODM/OEM products but non-warranty for PCBA with conformal coating. For outsourcing parts kit by Avalue (ex: Motherboard, LCD touch panel, CPU, RAM, HDD) are offered a 6-month warranty, and Mobile/Tablet PC battery are offered a warranty of the half year, from the date of delivery by Avalue. Products before the mass production stage, i.e. engineering samples are not applied in this warranty or service policy. For extended warranty and cross-territory services, product defects resulting from design, production process or material are covered by the pre-set warranty period after the date of delivery from Avalue. For non-Avalue products, the product warranty and repair time shall be based on the service standards provided by the original manufacturer; in principle Avalue will provide these products a warranty service for no more than one year.

2.2 Maintenance services within the warranty period

In the case of Avalue product DOA (Defect-on-Arrival) when the customer finds any defect within 1 month after the delivery, Avalue will replace it with a new product in a soonest way. Except for custom products, once the customer is approved of a Cross-Shipment Agreement, which allows for delivery a new product to the customer before receiving the defective one, Avalue will immediately proceed with new product replacement for the said DOA case. On validation of the confirmed defect, Avalue is entitled to reserve the right whether to provide a new product for replacement. For the returned defective new product, it is necessary to verify that there shall be no bruise, alteration, scratch or marking to the appearance, and that none of the delivered accessories missing; otherwise, the customer will be requested to pay a processing fee. On the other hand, if the new product defect is resulting from incorrect configuration or erroneous use by the user instead of any problem of the hardware itself, the customer will also be requested to pay for relevant handling fees.

As for other conditions, Avalue will handle defects by way of repair. The customer will be requested to send the defective product to an Avalue authorized service center, and Avalue will return the repaired product back to the customer as soon as possible.

2.3 Ruling of an out-of-warranty defect

The following situations are not included in the warranty:

- The warranty period has expired.
- Product has been altered or its label of the serial number has been torn off.
- Product functionality issues resulting from improper use by the user, unauthorized dismantle or alteration, unfit operation environment, improper maintenance, accident or other causes. Avalue reserves the right for the ruling of the aforementioned situations.
- Product damage resulting from lightning, flood, earthquake or other calamities.
- The warranty rules of non-Avalue products and accessories shall be in accordance with standards set up by the original manufacturer. These products and accessories include RAM, HDD, FDD, CD-ROM, CPU, FAN, etc.
- Product upgrade request or test request submitted by the customer after expiration of the warranty.
- PCBA with conformal coating.
- Avalue semi-product and outsourced products without Avalue serial number.
- Products before the mass production stage, i.e. engineering samples.

3. Procedure for sending for repair

3.1 Attain a RMA number

A customer's rejected product returned for repair shall have a RMA (Return Merchandise Authorization) number. Without a RMA number, Avalue will not provide any repair service for the rejected product, and the product will be returned to the customer at customer's cost. Avalue will not issue any notice for the return of the product.

Each returned product for repair shall have a RMA number, which is simply the authorization of the return for repair; it is not a guarantee that the returned goods can be repaired or replaced. For applying for a RMA number, the customer may enter the eRMA webpage of Avalue https://www.avalue.com/en/member and log-in with an account number and a password authorized by Avalue. The system will then automatically issue a RMA number.

When applying for the RMA number, it is essential to fill in basic information of the customer and the product, together with detailed description of the problem encountered. If possible, avoid using ambiguous words such as "does not work" or "problematic". Without a substantial description of the problem, it is hard to start the repair and will cause prolonged repair time. Lacking detailed statement of fault steps also makes the problem hard to be identified, sometimes resulting in second-time repairs.

In case the customer can't define the cause of problem, please contact Avalue application engineers. Sometimes when the problem can be resolved even before the customer sends back the product.

On the other hand, if the customer only returns the key parts to Avalue for repair, it is necessary that the serial number of the entire unit is given in the "Problem Description" field, so that warranty period can be ruled accordingly; or Avalue will handle the case as an Out-of- warranty case.

3.2 Return of faulty product for repair

It is recommended that the customer not to return the accessories (manual, connection cables, etc.) with the products for repair, devices such as CPU, DRAM, CF memory card, etc., shall also be removed from the faulty goods before return for repair. If these devices are relevant to described repair problems and necessary to be returned with the goods; please clearly indicate the items included in the eRMA application form. Avalue shall not be responsible for any item that is not itemized. Moreover, make sure the problem(s) are detailed in the "Problem Description" field.

In the list of delivery, the customer may fill-in a value which is lower than the actual value, to prevent customs levying a higher tax over the excessive value of the return goods. The customer shall be held responsible for extra fees caused by this. We strongly recommend that "Invoice for customs purpose only with no commercial value" be indicated on the delivery note. Also for the purpose of expedited handling, please printout the RMA number and put it in the carton, also indicate the number outside of the carton, with the recipient addressing to Avalue RMA Department.

When returning the defective product, please use an anti-static bag or ESD material to pack it properly. In case of improper packing resulting in damages in the transportation process, Avalue reserves the right to reject the un-repaired faulty good at the customer's costs. Furthermore, it is suggested that the faulty goods shall be sent via a door-to-door courier service. The customer shall be held responsible for any customs clearance fee or extra expenses if Air-Cargo is used for the delivery.

In case of a DOA situation of a new product, Avalue will be responsible for the product and the freight. If the faulty goods are within the warranty period, the sender will take responsibility for the freight. For an out-of-warranty case, the customer shall be responsible for the freight of both trips.

3.3 Maintenance Charge

Avalue will charge a moderate repair fee for the following conditions:

- The warranty period has expired.
- Product has been altered or its label of the serial number has been torn off.
- Product functionality issues resulting from improper use by the user, unauthorized dismantle or alteration, unfit operation environment, improper maintenance, accident

or other causes. Avalue reserves the right for the ruling of the aforementioned situations.

- Product damage resulting from lightning, flood, earthquake or other calamities.
- The warranty rules for non-Avalue products and accessories shall be in accordance with standards set up by the original supplier. These products and accessories include RAM, HDD, FDD, CD-ROM, CPU, FAN, etc.
- Product upgrade request or test request submitted by the customer after expiry of the warranty.
- PCBA with conformal coating.
- Avalue semi-product and outsourced products without Avalue serial number
- Products before the mass production stage, i.e. engineering samples.
- In case the products received are examined as NPF (No Problem Found) within the warranty period, the customer shall be responsible for the freight of both trips.
- Please contact your local distributor to examine in advance to prevent unnecessary freight cost.

For system failure of out-of-warranty products, Avalue will provide a quotation prior to repair service. When the customer applies for the cost, please refer to the Quotation number. In case the customer does not return the DOA product that has already been replaced by a new one, or the customer does not sign back the quotation of the out-of-warranty maintenance, Avalue reserves the right of whether or not to provide the repair service. In case the customer does not reply in 3 months, Avalue shall directly scrap or return the product back to customer at customer's cost without further notice to the customer.

3.4 Maintenance service of phased-out products

For servicing phased-out products, Avalue provides an extended period, starting the date of phase-out, as a guaranteed maintenance period of such products, for continuance of the maintenance service to meet customer's requirements. In case of unexpected factors causing Avalue to be unable to repair/replace a warranted but phased-out product, Avalue will, depending on the availability, upgrade the product (free of charge with continued warranty period as of the original product), or, give partial refund (based on the length of the remaining warranty period) to solve this kind of problem.

3.5 Maintenance Report

On completion of repair of a defective product, a Maintenance Report indicating the maintenance result and part(s) replaced (if any) will be sent to the customer together with the product. If the customer demands an additional maintenance analysis report, a service fee of various level will be charged depending on the warranty status. In case the analysis result shows that the defect attributes to Avalue's faulty design or process, the analysis fee will be exempted.

4. Service Products

Avalue provides service products to manage with different customer needs. Should you have any need, please consult to Avalue Sales Department.

Defect Analysis Report (DAR)

Avalue provides DAR (Defect Analysis Report) services aiming to elevating customer satisfaction. A DAR includes defect cause identification/verification/suggestion and improvement precautions, with instructions on correct usage for the avoidance of any reoccurrence.

Upgrade Service

Avalue is capable to provide system upgrade service for customization requirements. This upgrade service is applicable for main parts, such as CPU, memory, HDD, SSD, storage devices; also replacements motherboards of systems. Please contact Avalue sales for details to evaluate the possibility of system upgrade service and obtain information of lead time and price.

Explanation of Graphical Symbols

M	Warning	A WARNING statement provides important information about a potentially hazardous situation which, if not avoided, could result in death or serious injury.
\triangle	Caution	A CAUTION statement provides important information about a potentially hazardous situation which, if not avoided, may result in minor or moderate injury to the user or patient or in damage to the equipment or other property.
D	Note	A NOTE provides additional information intended to avoid inconveniences during operation.
DC		Direct current.
AC ~		Alternating current
<u></u>		Stand-by, Power on
FC		FCC Certification
CE		CE Certification
		Follow the national requirements for disposal of equipment.
<u>3</u>		Stacking layer limit
<u>††</u>		This side up

User's Manual

Y	Fragile Packaging
**	Beware of water damage, moisture-proof
	Carton recyclable
	Handle with care
	Follow operating instructions of consult instructions for use.
	WARNING
	INGESTION HAZARD: This product contains a button
	cell or coin battery.
	DEATH or serious injury can occur if ingested.
	A swallowed button cell or coin battery can cause
	Internal Chemical Burns in as little as 2 hours.
	KEEP new and used batteries OUT OF REACH of
	CHILDREN.
	Seek immediate medical attention if a battery is
	suspected to be swallowed or inserted inside any part of
	the body.

Disposing of your old product

WARNING:

There is danger of explosion if the battery is mishandled or incorretly replaced. Replace only with the same type of battery. Do not disassemble it or attempt to recharge it outside the system. Do not crush, puncture, dispose of in fire, short the external contacts, or expose to water or ther liquids. Dispose of the battery in accordance with local regulations and instructions from your service provider.

CAUTION:

- Lithium Battery Caution: Danger of explosion if battery is incorrectly replaced. Replace only with same or equivalent type. Dispose batteries according to manufacturer's instructions.
- Disposal of a BATTERY into fire or a hot oven, or mechanically crushing or cutting of a BATTERY, that can result in an EXPLOSION
- Leaving a BATTERY in an extremely high temperature surrounding environment that can result in an EXPLOSION or the leakage of flammable liquid or gas.
- A BATTERY subjected to extremely low air pressure that may result in an EXPLOSION or the leakage of flammable liquid or gas.

Mise en garde!

AVERTISSEMENT : Il existe un risque d'explosion si la batterie est mal manipulée ou remplacée de manière incorrecte. Remplacez uniquement par le même type de batterie. Ne le démontez pas et ne tentez pas de le recharger en dehors du système. Ne pas écraser, percer, jeter au feu, court-circuiter les contacts externes ou exposer à l'eau ou à d'autres liquides. Jetez la batterie conformément aux réglementations locales et aux instructions de votre fournisseur de services.

MISE EN GARDE:

- Pile au lithium Attention : Danger d'explosion si la pile n'est pas remplacée correctement. Remplacer uniquement par un type identique ou équivalent. Jetez les piles conformément aux instructions du fabricant.
- L'élimination d'une BATTERIE dans le feu ou dans un four chaud, ou l'écrasement ou le découpage mécanique d'une BATTERIE, pouvant entraîner une EXPLOSION
- Laisser une BATTERIE dans un environnement à température extrêmement élevée pouvant entraîner une EXPLOSION ou une fuite de liquide ou de gaz inflammable.
- UNE BATTERIE soumise à une pression d'air extrêmement basse pouvant entraîner une EXPLOSION ou une fuite de liquide ou de gaz inflammable.

Content

1.	Get	tting Started	17
1.1	S	Safety Precautions	17
1.2	Р	Packing List	18
1.3	M	lanual Objectives	19
1.4	S	System Specifications	20
1.5	Α	rchitecture Overview—Block Diagram	27
2.	Har	dware Configuration	28
2.1	Р	Product Overview	29
2.2	J	umper and Connector List	30
2.3	S	Setting Jumpers & Connectors	33
2	.3.1	Flash Security Override (JPFLASHSEC)	33
2	.3.2	ME FW update (JPME1)	33
2	.3.3	Force PWRON setting (JPALLPWRON1)	34
2	.3.4	Clear CMOS (JPBAT1)	34
2	.3.5	Boot UART5 setting (JPBOOT_UART5)	35
2	.3.6	SATA or PCIE select (JPSATASEL)	35
2	.3.7	CPLD JTAG header (JCPLD_JTAG1)	36
2	.3.8	System fan connector 1 (SYS_FAN1)	36
2	.3.9	System fan connector 2 (SYS_FAN2)	37
2	.3.10	System fan connector 3 (SYS_FAN3)	37
2	.3.11	System fan connector 4 (SYS_FAN4)	38
2	.3.12	System fan connector 5 (SYS_FAN5)	38
2	.3.13	System fan connector 6 (SYS_FAN6)	39
2	.3.14	CPU fan connector 1 (CPU_FAN1)	39
2	.3.15	CPU fan connector 2 (CPU_FAN2)	40
2	.3.16	SPI connector (JSPI1)	40
2	.3.17	Serial port 2 connector (JCOM2)	41
2	.3.18	BMC_UART5 debug connector (JCOM5)	41
2	.3.19	Serial General Purpose I/O connector (JSGPIO1)	42
2	.3.20	ATX 12V power connector 1 (ATX12V1)	42
2	.3.21	ATX 12V power connector 2 (ATX12V2)	43
2	.3.22	ATX 12V power connector 3 (ATX12V3)	43
2	.3.23	ATX power connector (ATXPWR1)	44
2	.3.24	Power supply PMBus connector (JPMBUS1)	44
2	.3.25	Front Panel USB2.0 connector (JUSB1)	45
2	.3.26	Front Panel USB3.1 connector (JUSB2)	45
2	.3.27	Front Panel connector 1 (JFP1)	46

HPI	/I-EKSD	DE USER'S Manual	
2.3	3.28 F	Front Panel connector 2 (JFP2)	46
2.3	3.29 I	Inlet Thermal Sensor (JINLET_SER1)	47
2.3	3.30	Outlet Thermal Sensor (JOUTLET_SER1)	47
2.3	3.31 H	HDD Backplane thermal Sensor (JHDD_SER1)	48
2.3	3.32	CASE OPEN connector (JCASE_OPEN1)	48
2.3	3.33 \	VROC Header (JRAID_KEY1)	49
2.3	3.34 (CPU PCIE HP SMB connector (JPEHPSMB1)	49
2.3	3.35 A	AZALIA connector (JAUDIO1)	50
2.3	3.36	SMBUS VR connector (JVR_PRG1)	50
2.3	3.37 E	ESPI connector (JESPI1)	51
2.3	3.38	CPLD SMBUS connector (JCPLD_SMB)	51
2.4	Proce	essor Installation SOP	52
3. D	rivers I	nstallation	59
3.1	Insta	II Chipset Driver	60
3.2	Insta	II VGA Driver	61
3.3	Insta	II Audio Driver	63
3.4	Insta	II Ethernet Driver	64
3.5	Insta	II QuickAssist Technology Driver	65
3.6		II VROC Driver	
4.BI	OS Set	up	68
4.1	Intro	duction	69
4.2	Start	ing Setup	69
4.3		g Setup	
4.4	•	ng Help	
4.5		ase of Problems	
4.6		S setup	
4.0		in Menu	
	4.6.1.1	System Language	72
	4.6.1.2	System Date	
	4.6.1.3	System Time	
4.0	6.2 Adv	vanced Menu	
	4.6.2.1	Trusted Computing	
	4.6.2.2	ACPI Settings	
	4.6.2.3	AST2600 Super IO Configuration	
	4.6.2.3.1		
	4.6.2.3.2		
	4.6.2.4	Serial Port Console Redirection	
	4.6.2.5	Option ROM Dispatch Policy	
	4.6.2.6	USB Configuration	
	4.6.2.7	Network Stack Configuration	
			, 0

User's Manual

4.	6.2.8	NVMe Configuration	81
4.6.3	B Pla	tform Config	81
4.	6.3.1	PCH-IO Configuration	82
4.	6.3.1.1	PCI Express Configuration	83
4.	6.3.1.2	SATA And RST Configuration	87
4.	6.3.1.3	USB Configuration	90
4.	6.3.1.4	HD Audio Configuration	91
4.	6.3.2	Server ME Configuration	91
4.6.4	4 Soc	ket Config	92
4.	6.4.1	Processor Configuration	92
4.	6.4.1.1	Per-Socket Configuration	93
4.	6.4.1.1.	1 CPU Socket 0 Configuration	93
4.	6.4.1.1.2	2CPU Socket 1 Configuration	94
4.	6.4.2	Memory Configuration	95
4.	6.4.2.1	Memory Topology	95
4.	6.4.3	IIO Configuration	96
4.	6.4.3.1	Socket0 Configuration	96
4.	6.4.3.1.	1 Port DMI	100
4.	6.4.3.1.2	2Port 1A(PCle Slot6), Port 2A(PCle Slot4), Port 3A(PCle Slot2), Port 4A(X550), Port 4C	(M.2),
Р	ort 4E(S	AS1), Port 4G(SAS1), Port 5A(SAS2), Port 5C(SAS2), Port 5E(SAS3), Port 5G(SAS3)	101
4.	6.4.3.2	Socket1 Configuration	102
		1 Port 1A(PCle Slot7), Port 2A(PCle Slot5), Port 3A(PCle Slot3), Port 5A(PCle Slot1)	
4.	6.4.3.3	Intel VT for Directed I/O (VT-d)	107
		Intel VMD technology	
4.	6.4.3.4.	I Intel VMD for Volume Management Device on Socket 0	108
4.	6.4.3.4.2	2Intel VMD for Volume Management Device on Socket 1	108
	6.4.4	Advanced Power Management Configuration	
4.	6.4.4.1	CPU P State Control	109
4.	6.4.4.2	CPU C State Control	110
4.6.5	5 Ser	ver Mgmt	111
4.	6.5.1	System Event Log	112
4.	6.5.2	Bmc self test log	113
4.	6.5.3	BMC network configuration	
4.	6.5.4	BMC User Settings	117
4.	6.5.4.1	BMC Add User Details	117
4.	6.5.4.2	BMC Delete User Details	
4.	6.5.4.3	BMC Change User Settings	
4.6.6	Sec	curity	119
4.	6.6.1	Secure Boot	
4.6.7	7 Boo	ot	120

	4.6.8	Save and exit	121
	4.6.8.	1 Save Changes and Exit	122
	4.6.8.	2 Discard Changes and Exit	122
	4.6.8.	3 Save Changes and Reset	122
	4.6.8.	4 Discard Changes and Reset	122
	4.6.8.	5 Save Changes	122
	4.6.8.	6 Discard Changes	122
	4.6.8.	7 Restore Defaults	122
	4.6.8.	8 Save as User Defaults	122
	4.6.8.	9 Restore User Defaults	122
5.	. Mecha	nical Drawing	123
6.	. Mainte	enance & Troubleshooting	125

1. Getting Started

1.1 Safety Precautions

Warning!



Always completely disconnect the power cord from your chassis whenever you work with the hardware. Do not make connections while the power is on. Sensitive electronic components can be damaged by sudden power surges. Only experienced electronics personnel should open the PC chassis.

Caution!



Always ground yourself to remove any static charge before touching the CPU card. Modern electronic devices are very sensitive to static electric charges. As a safety precaution, use a grounding wrist strap at all times. Place all electronic components in a static-dissipative surface or static-shielded bag when they are not in the chassis.

Risk of Explosion if Battery is replaced by an Incorrect Type. Dispose of Used Batteries According to the Instructions.

Français: Attention!



Débranchez le câble d'alimentation de votre châssis chaque fois que vous travaillez avec le matériel. Ne faites pas de connexion lorsque le système est allumé. Les composants électroniques sensibles peuvent être endommagés par les surtensions soudaines. Seule les personnels expérimentés de l'électronique peuvent ouvrir le châssis du PC.

Précaution!



Il faut toujours mettre à la masse pour éliminer l'électricité statique avant de toucher la carte CPU. Les appareils électroniques modernes sont très sensibles aux électricité statique. Pour des raisons de sécurité, utilisez un bracelet électrostatique. Placez tous les composants électroniques sur une surface antistatique ou dans un sac antistatique quand ils ne sont pas dans le châssis.

Risque d'explosion si la batterie est remplacée par un type incorrect. Jetez les piles usagées selon les instructions

Warning!



Class I Equipment. This equipment must be earthed. The power plug must be connected to a properly wired earth ground socket outlet. An improperly wired socket outlet could place hazardous voltages on accessible metal parts.

Warning!

IT Room



Suitable for installation in Information Technology Rooms in accordance with Article 645 of the National Electrical Code and NFPA 75.

Warning!

RAL



The device can only be used in a fixed location such as a lab or a machine room. When you install the device, ensure that the protective earthing connection of the socket-outlet is verified by a skilled person.

Warning!

For RTC battery, current statement in the manual is acceptable.



There is danger of explosion if the battery is mishandled or incorrectly replaced. Replace only with the same type of battery. Do not disassemble it or attempt to recharge it outside the system. Do not crush, puncture, dispose of in fire, short the external contacts, or expose to water or other liquids. Dispose of the battery in accordance with local regulations and instructions from your service provider.

1.2 Packing List

Before installation, please ensure all the items listed in the following table are included in the package.

Item	Description	Q'ty	
1	HPM-ERSDE motherboard	1	
2	I/O Shield	1	
3	LGA4677 CPU carrier-E1B	2	



If any of the above items is damaged or missing, contact your retailer.

1.3 Manual Objectives

This manual describes in details Avalue Technology HPM-ERSDE Single Board.

We have tried to include as much information as possible but we have not duplicated information that is provided in the standard IBM Technical References, unless it proved to be necessary to aid in the understanding of this board.

We strongly recommend that you study this manual carefully before attempting to set up HPM-ERSDE or change the standard configurations. Whilst all the necessary information is available in this manual we would recommend that unless you are confident, you contact your supplier for guidance.

Please be aware that it is possible to create configurations within the CMOS RAM that make booting impossible. If this should happen, clear the CMOS settings, (see the description of the Jumper Settings for details).

If you have any suggestions or find any errors regarding this manual and want to inform us of these, please contact our Customer Service department with the relevant details.

1.4 System Specifications

System	
CPU	Dual Intel LGA4677 Socket supports 5th Gen. Intel Xeon Scalable Processor
S. C	(Max. TDP at 270W)
BIOS	AMI UEFI BIOS
System Chipset	Intel C741 Chipset (DMI x8)
System Memory	12 x DDR5 5600MT/s RDIMM Up to 3TB
Watchdog Timer	System reset event
watchdog rimer	0~6553 second.
	Temperature.
H/W Status	Fan.
Monitor	Voltage.
	Case open. (1 x 2.5mm pitch Box Wafer, Pinrex 753-71-02TW07 or equivalent)
DAID	Intel VMD and Virtual RAID on CPU(VROC)
RAID	1 x Intel VROC header
TDM	TPM 2.0 NuvoTon NPCT750AADYX or equivalent
ТРМ	TCM Nationz Z32H330TC or equivalent (Optional)
Other	IPMI 2.0 with AST 2600 BMC controller onboard.
Expansion Slot	
	7 x PCIe Gen5 x16 slots
	Slot 1, PCIe Gen5 x16 from 2nd CPU
	Slot 2, PCIe Gen5 x16 from 1st CPU
201	Slot 3, PCIe Gen5 x16 from 2nd CPU
PCle	Slot 4, PCIe Gen5 x16 from 1st CPU
	Slot 5, PCIe Gen5 x16 from 2nd CPU
	Slot 6, PCIe Gen5 x16 from 1st CPU
	Slot 7, PCIe Gen5 x16 from 2nd CPU (This slot is closest to CPU socket)
Storage	
	1 x M.2 M-Key Slot to support 1 x PCle 5.0 x4 NVMe SSD from 1st CPU
M.2	2242/2260/2280/22110 form factor
	5 x SATA III Supports up to 6.0 Gb/s
SATA	-1 x Mini-SAS HD 4i (from PCH for 4 xSATA or 1 x4 NVMe interface)
	-1 x 7pin SATA connector
Other	3 x Slim SAS 8i (SFF-8654) connector (from 1st CPU)
Edge I/O	
0011	1 x DB-9 male connector
COM	(Connector: DB-9(male) and DB-15(female) dual port right angle)
LAN	5 x RJ45 (Including MGMT, LAN1, 2, 3, and 4)

				U	Jser's Manual		
	MGMT port: Dedicat	ed IPMI fu	unction acc	ess			
	LAN 1: 1GbE Etherr	et port, L	AN1 shared	d with IPMI function ac	ccess		
	(Connector: 1 x 1G	Base-T R	J45 modul	e jack over 2 x USB	3.1 Gen1 stacked		
	receptacle)						
	LAN 2: 2.5GbE Ethe	rnet port					
	(Connector: 1 x 2.50	Base-T	RJ45 modu	ıle jack over 2 x USB	3.1 Gen1 stacked		
	receptacle)						
	LAN 3 and 4: 2 x 10	LAN 3 and 4: 2 x 10GbE Ethernet ports (Optional)					
	(Connector: 1 x 2X1 10G Base-T RJ45 module jack)						
	4 x USB 3.1 type A ports +5VSB/0.9A						
	(Connector: 1 x 1G I	Base-T Ru	l45 module	jack over 2 x USB 3.	1 Gen1 stacked		
	receptacle)						
USB	(Connector: 1 x 2.50	Base-T l	RJ45 modu	ıle jack over 2 x USB 3	3.1 Gen1 stacked		
	receptacle)						
	(Connector: USB 3.0 type A double stacked USB receptacle).						
1/04	1 x DB-15 female co	nnector (0	Connector:	DB-9(male) and DB-1	5(female) dual		
VGA							
Onboard I/O							
COM	1 x RS232 ports (1 x	2.0mm p	itch Box He	eader)			
СОМ	Pin definition: Follow Avalue standard.						
	2 x USB 2.0 type A receptacle,+5VSB/0.5A						
	2 x USB 2.0 ports (1 x USB 2.0 2.54mm pitch Box Header) +5VSB/0.5A						
	Pin definition:						
	VCC	Pin 1	Pin 2	VCC]		
	USB0-	Pin 3	Pin 4	USB1-			
	USB0+	Pin 5	Pin 6	USB1+			
	GND	Pin 7	Pin 8	GND			
1100	Key	Pin 9	Pin 10	No Connection			
USB					_		
	2 x USB 3.1 Gen1 p	orts (1 x L	JSB 3.1 Ge	en1 2.0mm pitch Box H	leader (Pinrex		
	52X-8020GB52 or e	quivalent)	+5VSB/0.9) A	,		
	Pin definition :	. ,					
		Key					
		10					
		Over Curren	t				
	Vbus GND GND	Protect					

	Pin No. Signal Description							
		Vbus IntA_P1_SSR		ICC Port1	Supers	Spood Dv.		
		IntA_P1_SSR				Speed Rx+		
	4	GND	GND					
		IntA_P1_SST		ICC Port1	Super9	Speed Tx-		
		IntA_P1_SST) GND		ICC Port1	SuperS	Speed Tx+		
	,	IntA_P1_D-	GND	ICC Port1	D. (US	SB2 Signal D-)		
		IntA_P1_D+				SB2 Signal D+)		
	10	ID	Over (Current Pro	otection			
		IntA_P2_D+				SB2 Signal D+)		
		IntA_P2_D- GND		ICC Port2	D- (U	SB2 Signal D-)		
	10	IntA_P2_SST	K+ USB3	ICC Port2	SuperS	Speed Tx+		
		IntA_P2_SST		ICC Port2		•		
		GND	GND					
		IntA_P2_SSR IntA_P2_SSR				Speed Rx+		
		Vbus	A- USB3 Power	ICC Port2	Supers	Speed Rx-		
	2 v 4 Din	nitah O E	h 2.54mm CPU Fan Header (4 Pin PWM)					
		•			•	,		
CPU/System FAN	6 x 4 Pin, pitch 2.54mm Chassis Fan Header (4 Pin PWM, 2 for				/M, 2 for fro	nt fans and 4		
	for rear fans)							
Buzzer	1 x onbo	ard buzze	r					
	1 x front	panel con	nector (2.54	mm Pit	ch)			_
	Pin	Function		Pin	Function			
	1-3	HDD LED		2-4		POWER LE	ED	
Front Panel	5-7	RESET BUTTON		6-8		POWER BI		
	9-11	STATUS LED		10-12		LAN1 ACT		
	13-15	UID LED		14-16	5	STBY POV	VER LED	
	17-19	UID BI	UTTON	18-20 LAN2-X ACT LED				
	Notes: LA	AN2-X AC	T LED, "X" n	neans t	he m	ax number o	of Ethernet _I	ports.
RTC Battery	1 x Horiz	ontal Soc	ket Type CM	OS Bat	tery l	Holder with	CR2450 (15	years)
Clear CMOS	1 x Clear	CMOS h	eader (1 x 2.	0 mm p	itch I	Header)		
	1 x Avalu	ie HD auc	lio interface (1 x 6x2	2.0r	nm pitch wa	fer connecto	or)
	Sig	ınal	Pin			Pin	Signa	ı
	ACZ_	VCC3	1			2	GND	
Audio	ACZ_	SYNC	3		4		ACZ_BIT	CLK
Audio		SDOUT	5		6		ACZ_SD	
	ACZ_	SDIN1	7			8	ACZ_RS	ST#
	ACZ_	5VSB	9			10	GND-Cha	assis
	GI	ND	11			12	NC	
Display								
0	1 x VGA	port (DB1	5 on edge I/0	D)				
Graphic Chipset	AST2600	BMC co	ntroller					
Spec. & Resolution	VGA:192	0x1200@	60Hz 32bpp					

Ethernet 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1	Intel I21 Intel I22 Intel X55 Intel X55 IG Base 2.5G Ba	6-LM 50-AT2 e-T Ethernet Conti se-T Ethernet cor	roller atroller	ughte	er boar	d.							
Ethernet 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1	Intel I21 Intel I22 Intel X56 Intel X56 IGNORMAN	0AT 6-LM 50-AT2 e-T Ethernet Continue se-T Ethernet cor	roller atroller	ughte	er boar	d.							
1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x	Intel I22 Intel X55 1G Base 2.5G Ba	6-LM 50-AT2 e-T Ethernet Conti se-T Ethernet cor	ntroller										
1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x	Intel I22 Intel X55 1G Base 2.5G Ba	6-LM 50-AT2 e-T Ethernet Conti se-T Ethernet cor	ntroller										
LAN Spec. 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1 x 1	Intel I22 Intel X55 1G Base 2.5G Ba	6-LM 50-AT2 e-T Ethernet Conti se-T Ethernet cor	ntroller										
1 x 1 x 1 x 1 x 1 x 1 x	Intel X56 1G Base 2.5G Ba Dual 100	50-AT2 e-T Ethernet Contr se-T Ethernet cor	ntroller										
1 x 1 x 1 x	1G Base 2.5G Ba Dual 10	e-T Ethernet Contr se-T Ethernet cor	ntroller										
LAN Spec. 1 x 1 x 1 G	2.5G Ba Dual 10	se-T Ethernet cor	ntroller										
LAN Spec. 1 x 1 x 1 G	2.5G Ba Dual 10	se-T Ethernet cor	ntroller										
1 x	Dual 10												
16		G Base-T Etherne	t controlle										
	LAN:		1 x Dual 10G Base-T Ethernet controller										
Do													
Do			Right		Left								
Do	WOL	Status	Yellow	Gre		Orange							
	n't care	No Link											
	Off	S3/S4/S5	•										
	On	10Mb Inactive											
	On	10Mb Active	В										
	On On	100Mb Inactive 100Mb Active	В										
	On	1Gb Inactive											
	On	1Gb Active	В										
ED Indicator	WOL on't care Off On On	No Link S3/S4/S5 10Mb Inactive 10Mb Active	Yello		reen	Orange							
-	On On	1G/100Mb Inactive	e B		<u> </u>	2	-						
-	On	2.5Gb Inactive			•		1						
	On	2.5Gb Active	B		<u> </u>		1						
10	G LAN:	Status	Rig	ht low	Green	Left 1 Oran	ge						
Do	n't care	No Link											
	Off	S3/S4/S5			8	 3							
	On	100Mb Inactive			_								
	On	100Mb Active	1	В									
	On	1Gb Inactive 1Gb Active		D. D.									
	On On	10Gb Inactive		В									
	On	10Gb Active		В	X								
lechanical &													
vironmental													
vironmental	Ctd 01.	pin ATX Connecto	\r										

	Connector of	urrent	rating	inform	ation.					
	Connector current rating information. MAXIMUM CURRENT RATING(Amperes)									
			IVIA			Wire-to- Boar				
		Brass Phosphor Bronze								
	Ckt.Size Wire	2 & 3	4 - 6	7 - 10	12 - 24	Ckt.Size Wire	2 & 3	4 - 6	7 - 10	12 - 24
	AWG #16	9	8	7	6	AWG #16	8	7	6	5
	AWG #18 AWG #20	9	8	7 5	6 5	AWG #18 AWG #20	8	7 5	6	5 4
	AWG #20	5	4	4	4	AWG #20	4	3	3	3
	AWG #24	4	3	3	3	AWG #24	3	2	2	2
	AWG #26 AWG #28	3	2	2	2 1	AWG #26 AWG #28	1	1	1	1
ACPI	Yes, S0 and	1 S5						-		
7(0) 1	H/W: ATX p		vell de	sian or	ılv					
Power Mode	BMC: AT (C			oigii oi	y					
Operating Tomp	0 °C to 50 °	C (32°	F ~ 12	2°F)to	suppor	t up to 250V	V TDP	CPU		
Operating Temp.	0 °C to 40 °	C (32°	F ~ 10	4°F)to	suppor	t up to 270V	V TDP	CPU		
Storage Temp.	-40 °C to 85	s °C (-4	ŀ0°F∼	185°F)						
Operating Humidity	40°C 95% F	Relative	e Hum	idity, N	on-cond	densing				
Size (L x W)										
(Please consult product	Proprietary :	form fa	actor							
engineers for the production	'			447	٠,					
feasibility if the size is larger	12" x 16.452	•			38mm)					
than 410x360mm or smaller	PCB thickne	ess is 2	2.86mr	n						
than 80x70mm)										
Weight	2.2KG									
• • • • • • • • • • • • • • • • • • •		ue star	ndard t	est						
	Follow Avalue standard test. Random Vibration Operation									
	Reference IEC60068-2-64 Testing procedures									
	1. Test PSD : 0.00454G²/Hz , 1.5 Grms									
	System condition : operation mode									
	3. Test frequency : 5~500 Hz									
	4. Test axis : X,Y and Z axis									
	5. Test ti	me : 30	0 minu	tes per	each a	xis				
Vibration Test	6. Syster	n cond	lition :	Operat	ion mod	de				
	7. IEC60	068-2-	64 Tes	st Fh						
	Storage : mSATA									
	Random vibration test (Non-operation)									
	Reference I	EC600	068-2-6	64 Test	ing prod	cedures				
	1. PSD: 0.00808G ² /Hz , 2.0 Grms									
	Ji. FOD. (l '								
		peration	on mod	de						
	2. Non-C	•		de -500Hz						

		User's Manual
	5. 30 min. per each axis	
	6. System condition : Non-Operation mode	
	7. IEC 60068-2-64 Test:Fh	
	Package Vibration Test:	
	Reference IEC60068-2-64 Testing procedures	
	1. Test PSD : 0.026G²/Hz , 2.16 Grms	
	2. Non-operation mode	
	3. Test frequency : 5~500 Hz	
	4. Test axis : X,Y and Z axis	
	5. Test time : 30 minutes per each axis	
	6. IEC 60068-2-64 Test Fh	
	Follow Avalue standard test.	
	Reference ISTA 2A, Method : IEC-60068-2-32 Test:Ed	
	Test Ea : Drop Test	
Drop Test	1 Test phase : One corner, three edges, six faces	
	2 Test high : 96.5cm	
	3 Package weight : 5Kg	
	4 Test drawing	
	Windows:	
	Windows 10 IoT Enterprise LTSC 2021.	
	Windows 11.	
001-6	Windows Server IoT 2019 with VT-d disabled.	
OS Information	Windows Server IoT 2022.	
	Linux :	
	Ubuntu 21.10, 22.04 LTS or later	
	Red Hat Enterprise Linux (RHEL) 8.4 LTS/8.5 or later	



Note: Specifications are subject to change without notice.

*Only Install CPU1

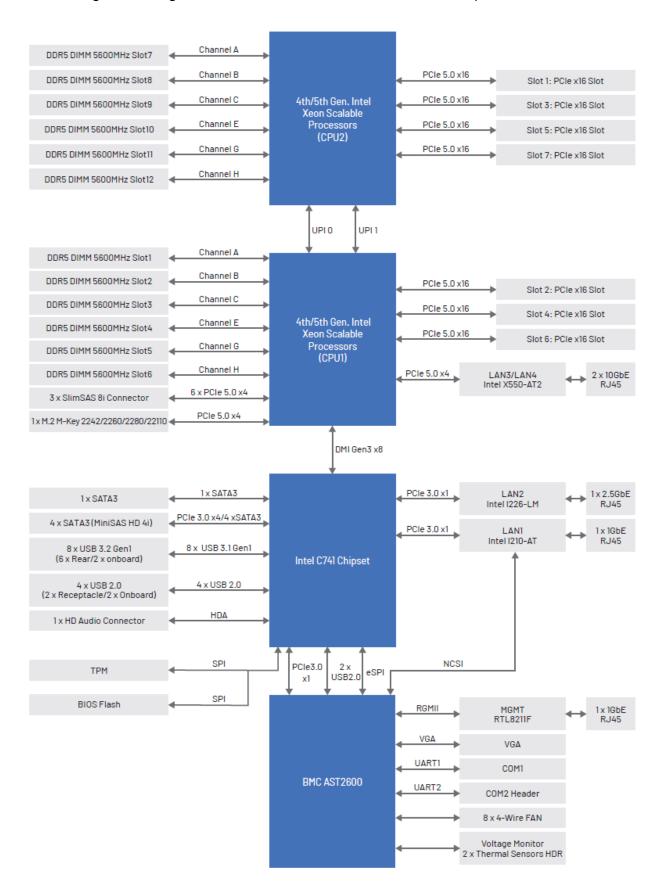
	DIMM No.							
DIMM Qty	DIMM1	DIMM2	DIMM3	DIMM4	DIMM5	DIMM6		
	V							
1		V						
				V				
2	V				V			
2			V	V				
4	V		V	V	V			
6	V	V	V	V	V	V		

*Install CPU1 and CPU2

						DIMI	M No.					
DIMM Qty	DIMM1	DIMM2	DIMM3	DIMM4	DIMM5	DIMM6	DIMM7	DIMM8	DIMM9	DIMM10	DIMM11	DIMM12
	V											
1		V										
				V								
	V						V					
	V							V				
	V									V		
		V					V					
2		V						V				
		V								V		
				V			V					
				V				V				
				V						V		
	V				V		V		T.7	***	V	
4	V		T 7	T 7	V		T 7		V	V	7.7	
			V	V V			V		V	V	V	
	V		V	V	V		V		V	V	V	
	V		V	V	V		V		V	V	V	
6	V		V	V	V		V		V	V	V	
	· ·		V	V	<u> </u>		V		V	V	V	
	V		V	V	V		V		V	V	V	
	V	V	V	V	V	V	V				V	
8	V	V	V	V	V	V			V	V		
	V				V		V	V	V	V	V	V
			V	V			V	V	V	V	V	V
10	V	V	V	V	V	V	V		V	V	V	
10	V		V	V	V		V	V	V	V	V	V
12	V	V	V	V	V	V	V	V	V	V	V	V

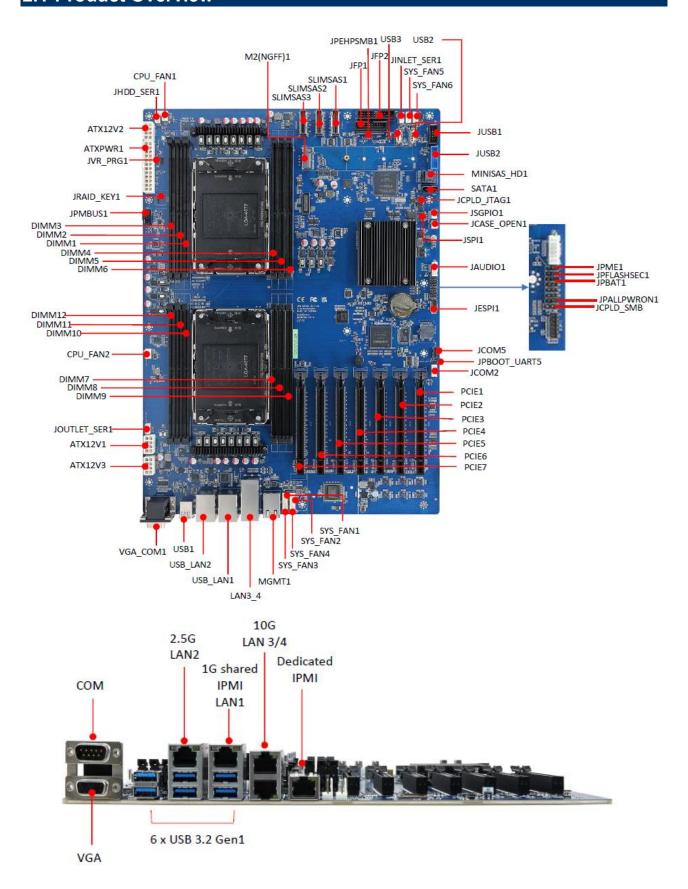
1.5 Architecture Overview—Block Diagram

The following block diagram shows the architecture and main components of HPM-ERSDE.



2. Hardware Configuration

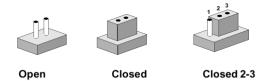
2.1 Product Overview



2.2 Jumper and Connector List

You can configure your board to match the needs of your application by setting jumpers. A jumper is the simplest kind of electric switch.

It consists of two metal pins and a small metal clip (often protected by a plastic cover) that slides over the pins to connect them. To "close" a jumper you connect the pins with the clip. To "open" a jumper you remove the clip. Sometimes a jumper will have three pins, labeled 1, 2, and 3. In this case, you would connect either two pins.



The jumper settings are schematically depicted in this manual as follows:



A pair of needle-nose pliers may be helpful when working with jumpers.

Connectors on the board are linked to external devices such as hard disk drives, a keyboard, or floppy drives. In addition, the board has a number of jumpers that allow you to configure your system to suit your application.

If you have any doubts about the best hardware configuration for your application, contact your local distributor or sales representative before you make any changes.

The following tables list the function of each of the board's jumpers and connectors.

Jumpers		
Label	Function	Note
JPFLASHSEC1	Flash Security Override	3 x 1 header, pitch 2.00mm
JPME1	ME FW update	3 x 1 header, pitch 2.00mm
JPALLPWRON1	Force PWRON setting	3 x 1 header, pitch 2.00mm
JPBAT1	Clear CMOS	3 x 1 header, pitch 2.00mm
JPBOOT_UART5	Boot UART5 setting	3 x 1 header, pitch 2.00mm
JPSATASEL	SATA or PCIE select	3 x 1 header, pitch 2.00mm

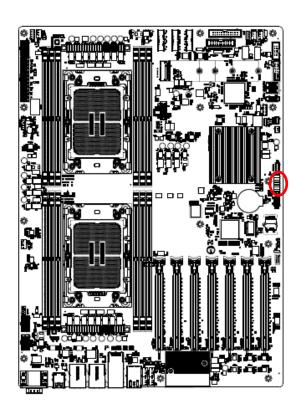
Connectors		
Label	Function	Note
SYS_FAN1-6	System fan connector 1-6	4 x 1 wafer, pitch 2.54mm
CPU_FAN1-2	CPU fan connector 1-2	4 x 1 wafer, pitch 2.54mm
VGA_COM1	Serial port 1 connector	

		User's Manual
	VGA connector	
JCOM2	Serial port 2 connector	5 x 2 wafer, pitch 2.00mm
JCOM5	BMC_UART5 debug connector	4 x 1 header, pitch 2.54mm
MGMT1	MGMT port	
JSGPIO1	Serial General Purpose I/O connector	3 x 2 wafer, pitch 2.00mm
PCIE1	PCIe Gen5 x16	
PCIE2	PCIe Gen5 x16	
PCIE3	PCIe Gen5 x16	
PCIE4	PCIe Gen5 x16	
PCIE5	PCIe Gen5 x16	
PCIE6	PCle Gen5 x16	
PCIE7	PCIe Gen5 x16 (The slot closest to CPU)	
JFP1	Front Panel connector 1	10 x 2 wafer, pitch 2.54mm
JFP2	Front Panel connector 2	12 x 2 wafer, pitch 2.54mm
USB_LAN1	2 x USB3.1 Gen1 connector 1 x RJ-45 Ethernet (LAN1 Share IPMI Port)	
USB_LAN2	2 x USB3.1 Gen1 connector 1 x RJ-45 Ethernet	
LAN3_4	2 x RJ-45 Ethernet	
USB1	2 x USB3.1 Gen1 connector	
USB2/3	2 x USB2.0 connector	
JUSB1	2 x USB2.0 connector	5 x 2 wafer, pitch 2.54mm
JUSB2	2 x USB3.1 Gen1 connector	10 x 2 wafer, pitch 2.00mm
JSPI1	SPI connector	4 x 2 header, pitch 2.00mm
JESPI1	ESPI connector	6 x 2 header, pitch 2.00mm
SATA1	Serial ATA connector	
MINISAS-HD1	Mini-SAS HD 4i (from PCH for 4 xSATA or 1 x4 NVMe interface)	
SLIMSAS1-3	3 x SlimSAS 8i connector for 6 x4 NVMe	
JRAID_KEY1	VROC Header	4 x 1 header, pitch 2.00mm
DIMM1-12	12 x DDR5 RDIMM socket	
JVR_PRG1	SMBUS VR connector	3 x 1 header, pitch 2.54mm
JCASE_OPEN1	CASE OPEN connector	2 x 1 wafer, pitch 2.50mm

ATX12V1	ATX 12V power connector 1	4 x 2 wafer, pitch 4.20mm
ATX12V2	ATX 12V power connector 2	4 x 2 wafer, pitch 4.20mm
ATX12V3	ATX 12V power connector 3	4 x 2 wafer, pitch 4.20mm
ATXPWR1	ATX power connector	12 x 2 wafer, pitch 4.20mm
JPMBUS1	Power supply PMBus connector	5 x 1 wafer, pitch 2.54mm
JINLET_SER1	Inlet Thermal Sensor	4 x 1 wafer, pitch 2.00mm
JOUTLET_SER1	Outlet Thermal Sensor	4 x 1 wafer, pitch 2.00mm
JHDD_SER1	HDD Backplane thermal Sensor	5 x 1 wafer, pitch 2.00mm
JPEHPSMB1	CPU PCIE HP SMB connector	5 x 1 header, pitch 2.00mm
JAUDIO1	AZALIA connector	6 x 2 header, pitch 2.00mm
M2(NGFF)1	M.2 M-Key PCle 5.0 x4 NVMe SSD	
JCPLD_JTAG1	CPLD JTAG header	5 x 2 header, pitch 2.54mm
JCPLD_SMB	CPLD SMBUS connector	3 x 1 header, pitch 2.54mm

2.3 Setting Jumpers & Connectors

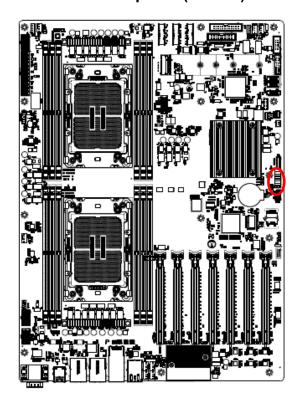
Flash Security Override (JPFLASHSEC) 2.3.1

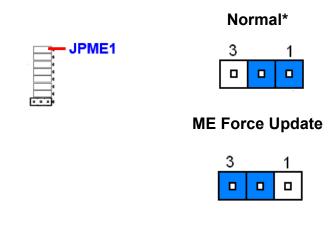






2.3.2 ME FW update (JPME1)

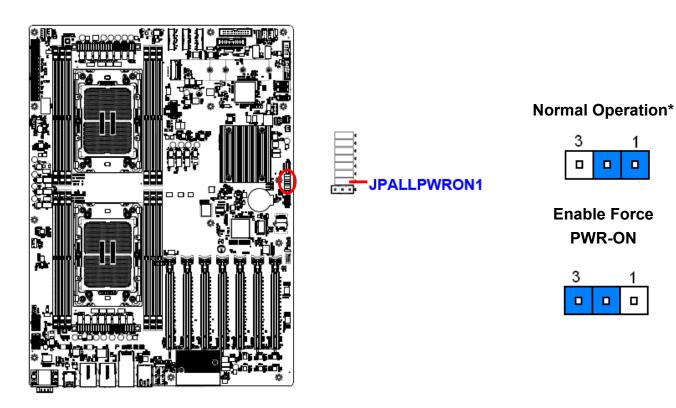




^{*} Default

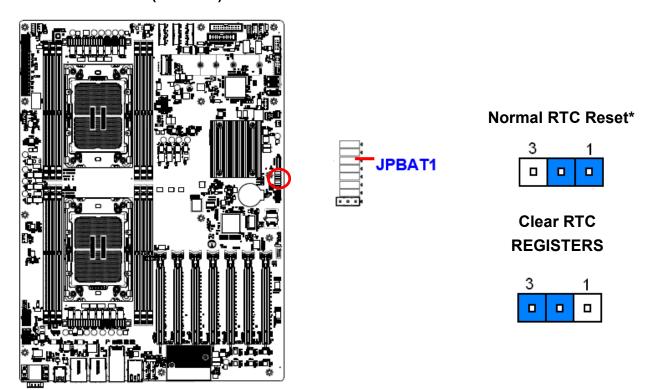
^{*} Default

2.3.3 Force PWRON setting (JPALLPWRON1)



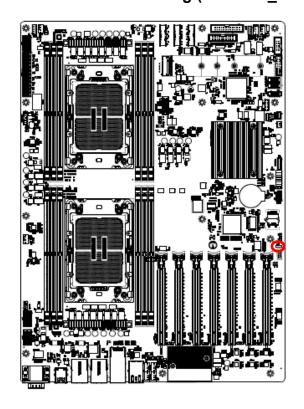
^{*} Default

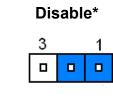
2.3.4 Clear CMOS (JPBAT1)



^{*} Default

2.3.5 **Boot UART5 setting (JPBOOT_UART5)**

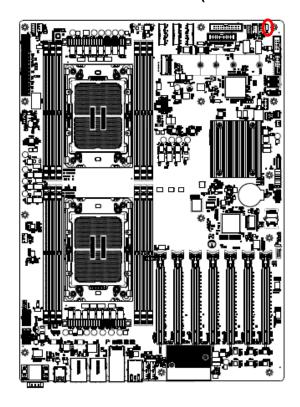




Enable BOOT FROM UART5



2.3.6 **SATA or PCIE select (JPSATASEL)**

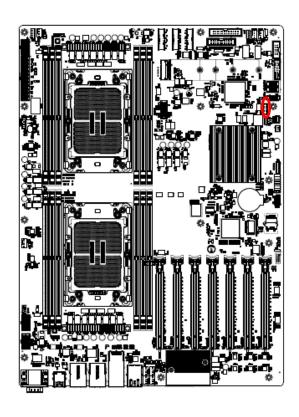


PCIE* 3 **SATA** 3

^{*} Default

^{*} Default

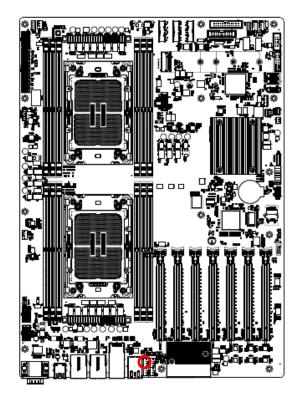
2.3.7 CPLD JTAG header (JCPLD_JTAG1)



1	
	_
	0
	_
9	_

Signal	PIN	PIN	Signal
JTAG_TCK	1	2	GND
JTAG_TDO	3	4	+3.3VSB
JTAG_TMS	5	6	NC
NC	7	8	NC
JTAG_TDI	9	10	GND

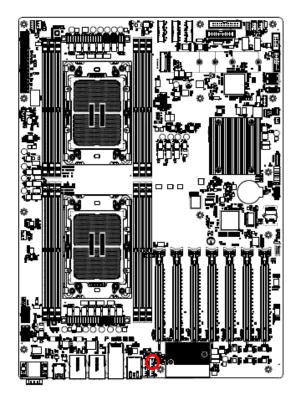
2.3.8 System fan connector 1 (SYS_FAN1)





Signal	PIN
SYS_PWM1	4
FAN_TACH1	3
+12V	2
GND	1

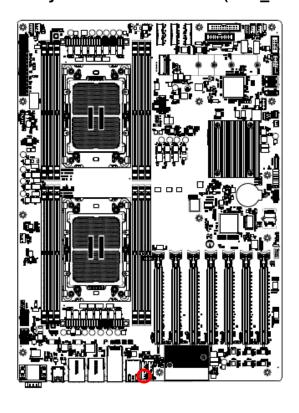
2.3.9 System fan connector 2 (SYS_FAN2)





Signal	PIN
SYS_PWM2	4
FAN_TACH2	3
+12V	2
GND	1

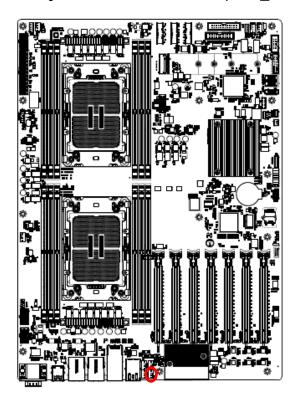
2.3.10 System fan connector 3 (SYS_FAN3)





Signal	PIN
SYS_PWM3	4
FAN_TACH3	3
+12V	2
GND	1

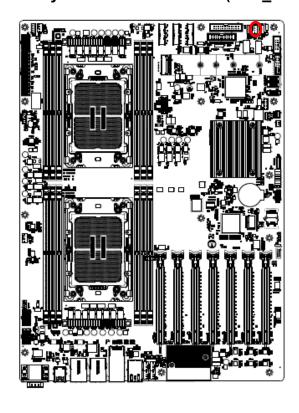
2.3.11 System fan connector 4 (SYS_FAN4)





Signal	PIN
SYS_PWM4	4
FAN_TACH4	3
+12V	2
GND	1

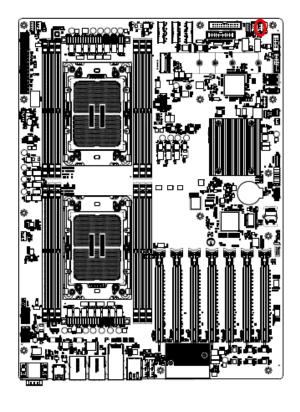
2.3.12 System fan connector 5 (SYS_FAN5)





Signal	PIN
GND	1
+12V	2
FAN_TACH5	3
SYS_PWM5	4

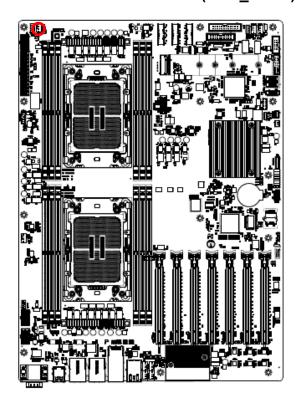
2.3.13 System fan connector 6 (SYS_FAN6)





Signal	PIN
GND	1
+12V	2
FAN_TACH6	3
SYS_PWM6	4

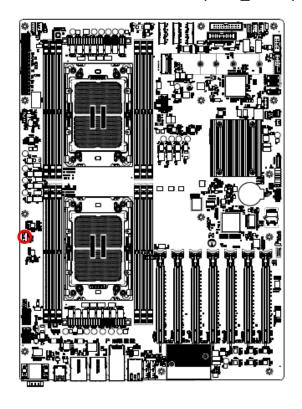
2.3.14 CPU fan connector 1 (CPU_FAN1)





Signal	PIN
GND	1
+12V	2
FAN_TACH0	3
CPU0_PWM	4

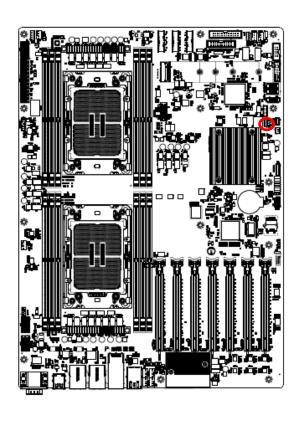
2.3.15 CPU fan connector 2 (CPU_FAN2)





Signal	PIN
GND	1
+12V	2
FAN_TACH7	3
CPU1_PWM	4

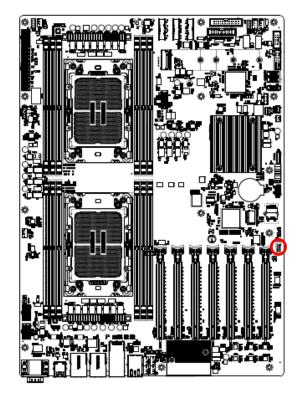
2.3.16 SPI connector (JSPI1)



	7
	1

Signal	PIN	PIN	Signal
SPI_IO2	8	7	SPI_IO3
SPI_MOSI	6	5	SPI_MISO
SPI_CLK	4	3	SPI_CS#
GND	2	1	+3.3VSB

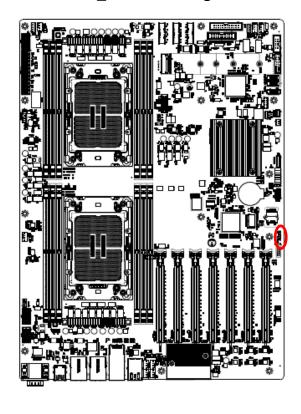
2.3.17 Serial port 2 connector (JCOM2)





Signal	PIN	PIN	Signal
COM_RXD2	2	1	COM_DCD#2
COM_DTR#2	4	3	COM_TXD2
COM_DSR#2	6	5	GND
COM_CTS#2	8	7	COM_RTS#2
NC	10	9	COM_RI#2

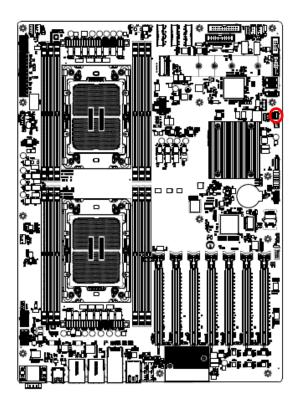
2.3.18 BMC_UART5 debug connector (JCOM5)





Signal	PIN
+3.3VSB	4
GND	3
UART5_RX	2
UART5_TX	1

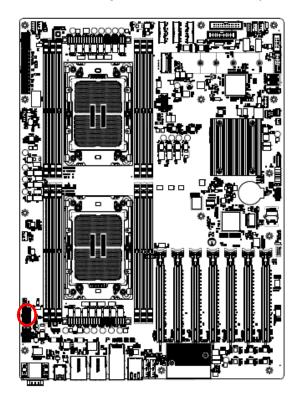
2.3.19 Serial General Purpose I/O connector (JSGPIO1)





Signal	PIN	PIN	Signal
GND	2	1	GND
SGPIO_DATAOUT	4	3	SGPIO_LOAD
NC	6	5	SGPIO_CLOCK

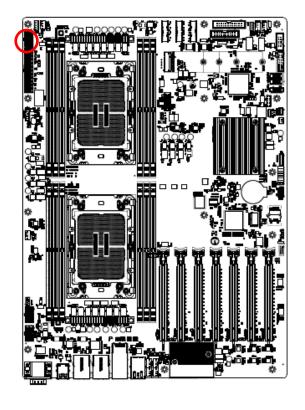
2.3.20 ATX 12V power connector 1 (ATX12V1)





Signal	PIN	PIN	Signal
+12V	5	1	GND
+12V	6	2	GND
+12V	7	3	GND
+12V	8	4	GND

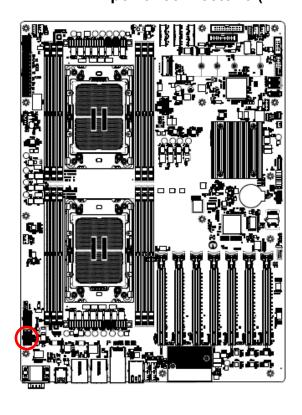
2.3.21 ATX 12V power connector 2 (ATX12V2)





Signal	PIN	PIN	Signal
+12V	5	1	GND
+12V	6	2	GND
+12V	7	3	GND
+12V	8	4	GND

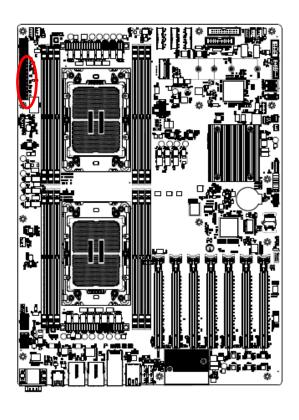
2.3.22 ATX 12V power connector 3 (ATX12V3)

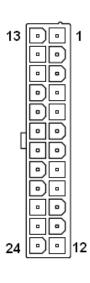




Signal	PIN	PIN	Signal
+12V	5	1	GND
+12V	6	2	GND
+12V	7	3	GND
+12V	8	4	GND

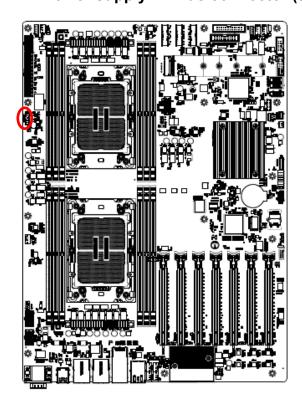
2.3.23 ATX power connector (ATXPWR1)

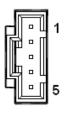




Signal	PIN	PIN	Signal
+3.3V	13	1	+3.3V
-12V	14	2	+3.3V
GND	15	3	GND
PSON#	16	4	+5V
GND	17	5	GND
GND	18	6	+5V
GND	19	7	GND
NC	20	8	PSU_PWRGD
+5V	21	9	+V5SB
+5V	22	10	+12V
+5V	23	11	+12V
GND	24	12	+3.3V

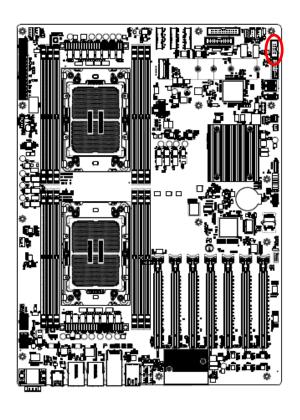
2.3.24 Power supply PMBus connector (JPMBUS1)





Signal	PIN
SMB_PSU_SCL	1
SMB_PSU_SDA	2
SMB_PSU_ALERT#	3
GND	4
NC	5

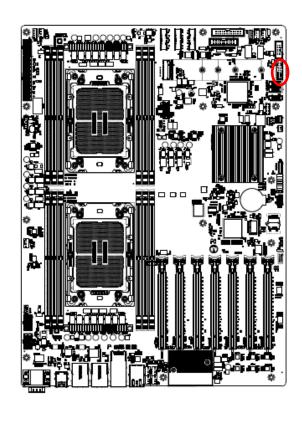
2.3.25 Front Panel USB2.0 connector (JUSB1)

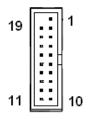




Signal	PIN	PIN	Signal
NC	10		
GND	8	7	GND
USB_PP8	6	5	USB_PP9
USB_PN8	4	3	USB_PN9
+5V	2	1	+5V

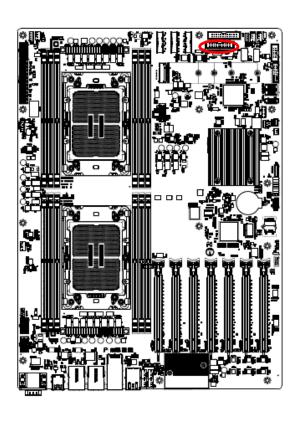
2.3.26 Front Panel USB3.1 connector (JUSB2)

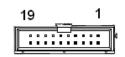




Signal	PIN	PIN	Signal
		1	+5V
+5V	19	2	USB3_RN6
USB3_RN7	18	3	USB3_RP6
USB3_RP7	17	4	GND
GND	16	5	USB3_TN6
USB_TN7	15	6	USB3_TP6
USB_TP7	14	7	GND
GND	13	8	USB3_PN11
USB_PN13	12	9	USB3_PP11
USB_PP13	11	10	USB_OC2#

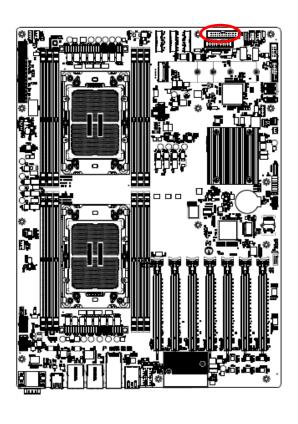
2.3.27 Front Panel connector 1 (JFP1)

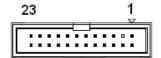




Signal	PIN	PIN	Signal
+3.3VSB	2	1	HDD_LED_P
PWR_LED#	4	3	HDD_LED#
PWRON_BUTTON#	6	5	RESET_BUTTON#
GND	8	7	GND
LAN1_LED_P	10	9	STATUS_LED_P
LAN1_LED#	12	11	STATUS_LED#
SBPWRLED_P	14	13	UID_LED#
GND	16	15	UID_LED_P
LAN2-X_LED_P	18	17	UID_BUTTON#
LAN2-X_LED#	20	19	GND

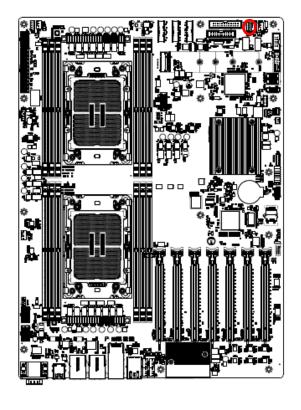
2.3.28 Front Panel connector 2 (JFP2)





Signal	PIN	PIN	Signal
+3.3VSB	2	1	+3.3VSB
UID_LED_P	4		
UID_LED#	6	5	PWR_LED#
STATUS_LED#	8	7	HDD_LED_P
STATUS_LED_P	10	9	HDD_LED#
LAN1_LED_P	12	11	PWRON_BUTTON#
LAN1_LED#	14	13	GND
SMBus_SDA	16	15	RESET_BUTTON#
SMBus_SCL	18	17	GND
INTRUSION#	20	19	UID_BUTTON#
LAN2-X_LED_P	22	21	NC
LAN2-X_LED#	24	23	NMI_BUTTON#

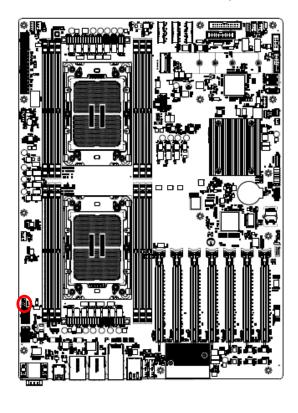
2.3.29 Inlet Thermal Sensor (JINLET_SER1)





Signal	
+3.3VSB	1
SMB_INLET_TEMPSENSOR_SDA	2
SMB_INLET_TEMPSENSOR_SCL	3
GND	4

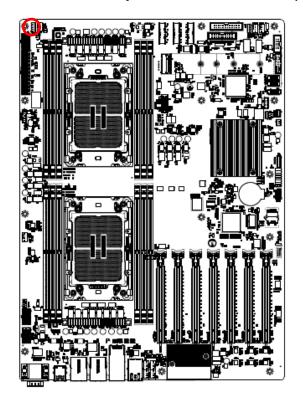
2.3.30 Outlet Thermal Sensor (JOUTLET_SER1)





Signal	PIN
GND	4
SMB_OUTLET_TEMPSENSOR_SCL	3
SMB_OUTLET_TEMPSENSOR_SDA	2
+3.3VSB	1

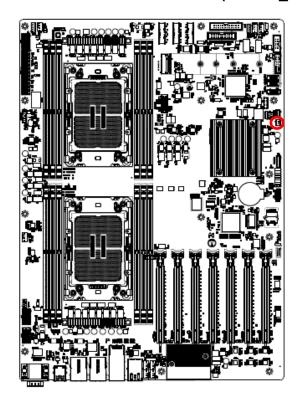
2.3.31 HDD Backplane thermal Sensor (JHDD_SER1)





Signal	PIN
SSD_LED_N	5
GND	4
SMB_HDBP_TEMPSENSOR_SCL	3
SMB_HDBP_TEMPSENSOR_SDA	2
+3.3VSB	1

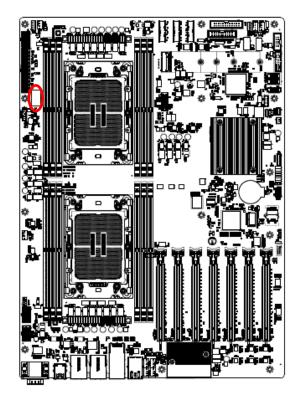
2.3.32 CASE OPEN connector (JCASE_OPEN1)

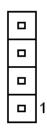




Signal	PIN
CHASSIS_INTRUSION	1
GND	2

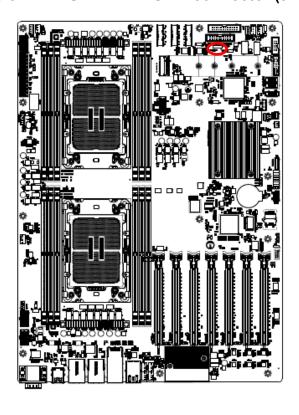
2.3.33 VROC Header (JRAID_KEY1)





Signal	PIN
PCH_SATA_RAIDKEY	4
GND	3
PU_LEY_CONN	2
GND	1

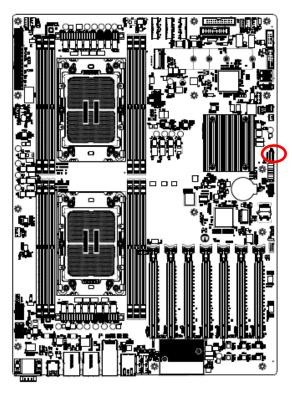
2.3.34 CPU PCIE HP SMB connector (JPEHPSMB1)





Signal	PIN
SMB_CPUHP_SCL	1
GND	2
SMB_CPUHP_SDA	3
GND	4
SMB_CPUHP_ALERT#	5

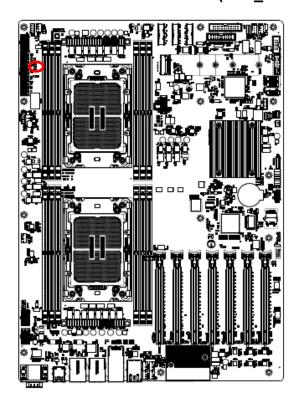
2.3.35 AZALIA connector (JAUDIO1)





Signal	PIN	PIN	Signal
GND	2	1	+3.3V
AUD_AZA_BCLK	4	3	AUD_AZA_SYNC
AUD_AZA_SDI0	6	5	AUD_AZA_SDO
AUD_AZA_RST#	8	7	AUD_AZA_SDI1
GND	10	9	+5VSB
NC	12	11	GND

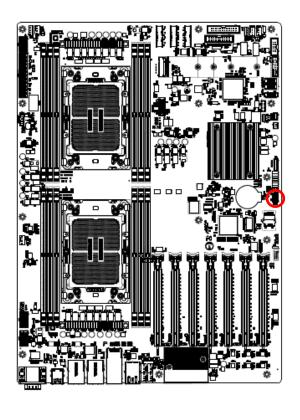
2.3.36 SMBUS VR connector (JVR_PRG1)





Signal	PIN
SMB_VR_SDA	1
GND	2
SMB_VR_SCL	3

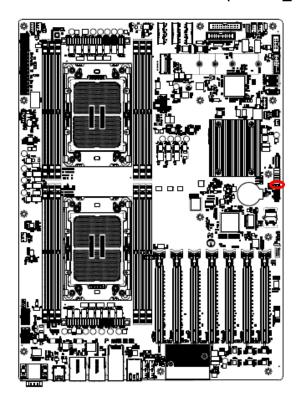
2.3.37 ESPI connector (JESPI1)

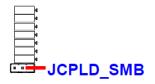


	11
0	1

Signal	PIN	PIN	Signal
ESPI_ALERT#	12	11	ESPI_RESET#
GND	10	9	NC
ESPI_CLK	8	7	ESPI_D3
ESPI_CS#	6	5	ESPI_D2
PLTRST#	4	3	ESPI_D1
+3.3VSB	2	1	ESPI_D0

2.3.38 CPLD SMBUS connector (JCPLD_SMB)







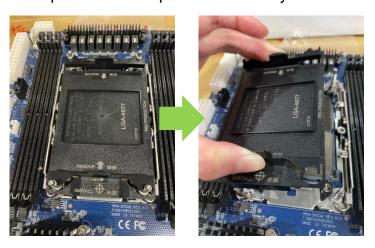
Signal	
SMB_DEBUG_PLD_R_SDA	1
GND	2
SMB_DEBUG_PLD_R_SCL	3

2.4 Processor Installation SOP

Overview of the Processor Assembly installation procedure

Note: Suggest installing the memory first, then installing the CPU cooler module to lower the memory installation difficulty.

- 1. The CPU socket is protected by a plastic protective cover.
- a. Hold finger grips on socket cover and squeeze in on the grip tabs.
- b. Then pull the cover up and off vertically to remove.



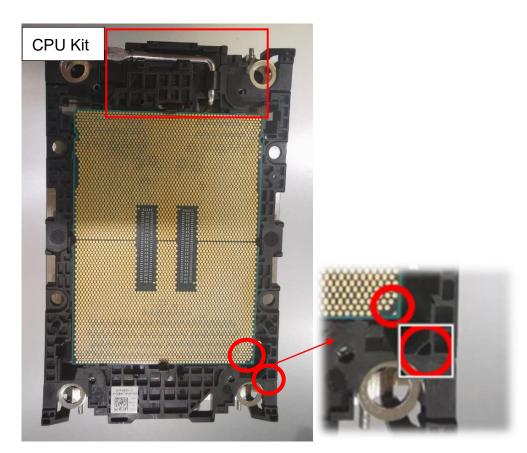
- 2. The processor assembly contains the Intel Xeon SP with carrier and CPU cooler.
 - -1x Intel 4th /5th Xeon SP(MCC & LCC SKU)
 - -1x E1B CPU Carrier (In the HPM-ERSDE package)
 - -1x Cooler module (Avalue P/N:BCC-FAN-467-01R)

Please ensure the carrier model on the CPU is consistent with the carrier silkscreen.





Install the CPU on the carrier and align the triangle marks (Pin 1). Look at the below red frame, please make sure the lever is pressed down.



Install the CPU kit assembly on the cooler module, please press down the CPU kit to fixate it.

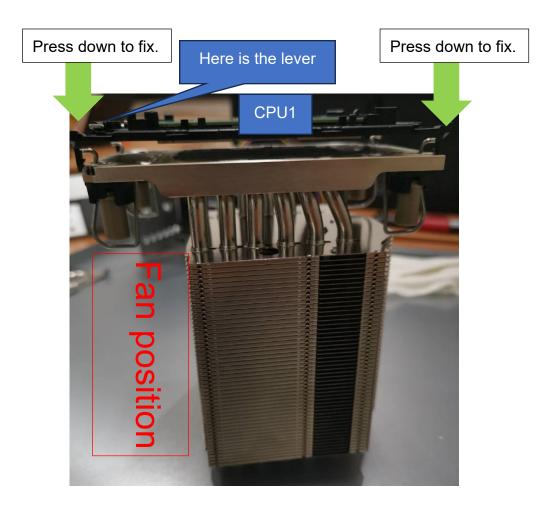
CPU1: Make sure the lever on the carrier is on the same side as the fan.

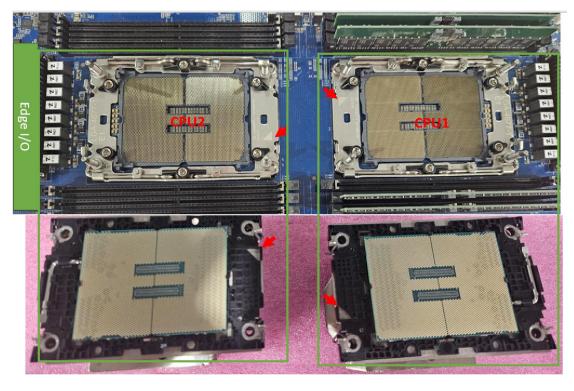
CPU2: Make sure the lever on the carrier is on a different side than the fan.

(Only applicable to HPM-ERSDE and Avalue Cooler BCC-FAN-467-01R.)

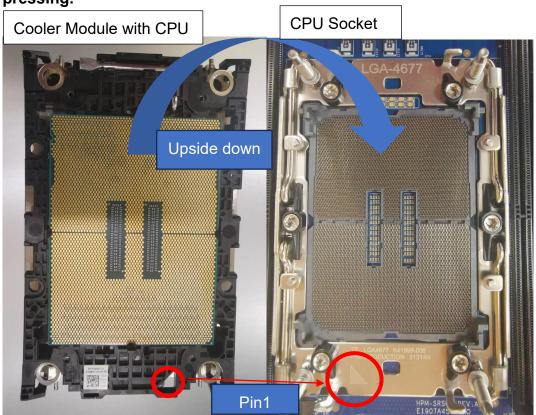
Note: The Thermal grease must be pre-applied on the heatsink before installation.

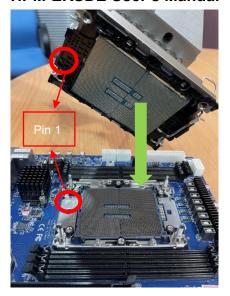
Note: Please ensure the direction of the fan before installing the CPU kit on the Cooler module.



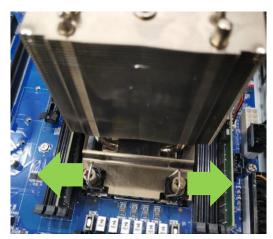


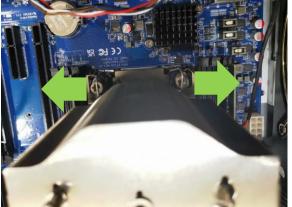
- Cooler module with CPU kit installed on the motherboard.
- a. Please align the triangle mark between the Cooler module and CPU socket and install it. (Figure A)
- b. Hold the Cooler module with the CPU and align the holes with the CPU socket. Press the Cooler module down to the CPU socket until it snaps into place.
- c. Press down the fixing tenons on the four sides to fixate. (Figure B)
- d. With a T30 screwdriver, gradually tighten the four screws to ensure even pressure. (Figure C)
- ★ The cooler module with CPU pin1 must be aligned with the CPU socket pin1 mark, and the direction cannot be changed at will, or it may cause the CPU to damage after pressing.



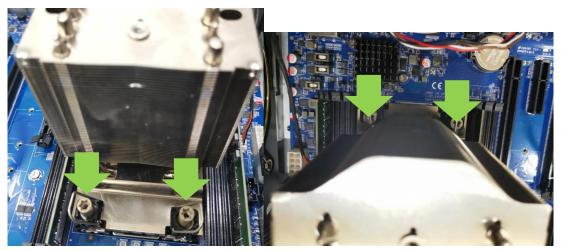


▲ Figure A





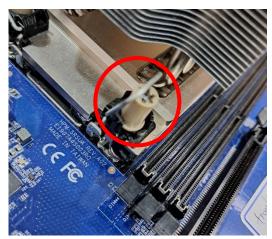
▲ Figure B



▲ Figure C

▼Before locking the tenons

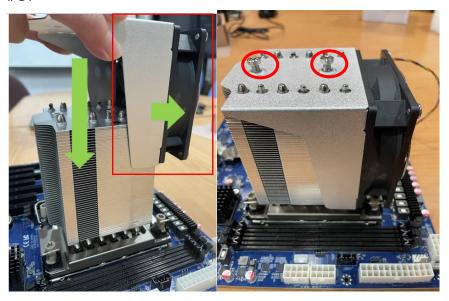
▼After locking the tenons





Install the cooling fan and holder on the cooler module and tighten two locking screws (T30) on the top of the fan holder.

Note: The 4U cooler's fan for Xeon SP dual sockets is facing the opposite side of Edge I/O.

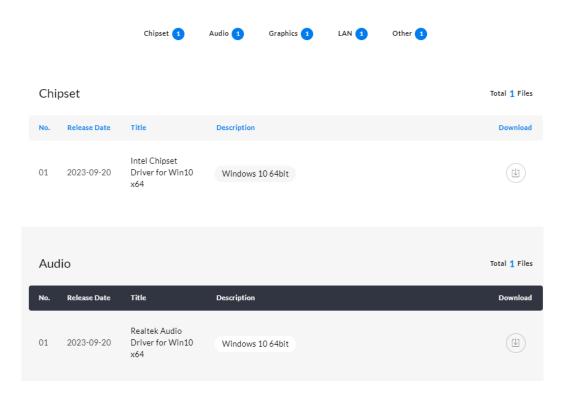




7. Connect the cooling fan connector to the fan header labeled for the CPU on the motherboard.

3. Drivers Installation

All the drivers are available on Avalue Downloads Area (https://www.avaluetech.com/en/support/download). Type the model name and press Enter to find all the relevant software, utilities, and documentation.





Note: Installation procedures and screen shots in this section are for your reference and may not be exactly the same as shown on your screen.

3.1 Install Chipset Driver

All drivers can be found on the Avalue Official Website:

www.avalue.com.



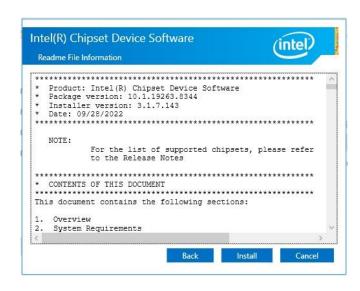
Note: The installation procedures and screen shots in this section are based on Windows 10 operation system. If the warning message appears while the installation process, click Continue to go on.



Step1. Click Next.



Step 2. Click Accept.



Step 3. Click Install.



Step 4. Setup completed.

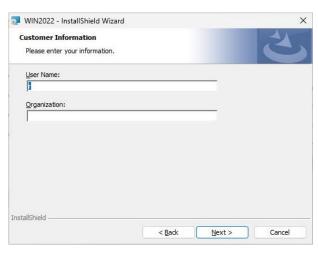
3.2 Install VGA Driver

All drivers can be found on the Avalue Official Website:

www.avalue.com



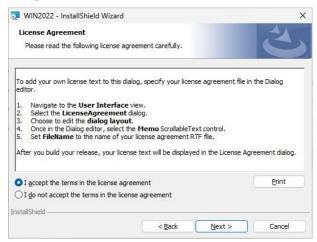
Note: The installation procedures and screen shots in this section are based on Windows 10 operation system.



Step 3. Click Next.



Step 1. Click **Next** to continue installation.



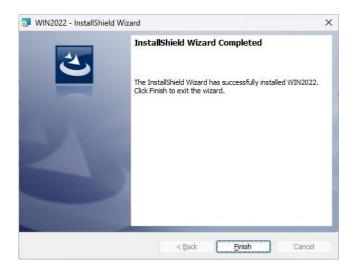
Step 2. Click Next.



Step 4. Click Next.



Step 5. Click Install.



Step 6. Click Finish to complete setup.

3.3 Install Audio Driver

All drivers can be found on the Avalue Official Website:

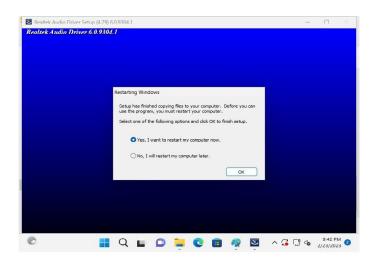
www.avalue.com.



Note: The installation procedures and screen shots in this section are based on Windows 10 operation system.



Step 1. Click Yes to continue installation.



Step 2. Setup completed.

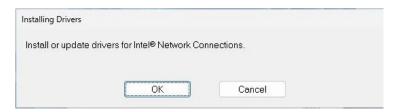
3.4 Install Ethernet Driver

All drivers can be found on the Avalue Official Website:

www.avalue.com.



Note: The installation procedures and screen shots in this section are based on Windows 10 operation system.



Step 1. Click OK to continue installation.



Step 2. Setup completed.

3.5 Install QuickAssist Technology Driver

All drivers can be found on the Avalue Official Website:

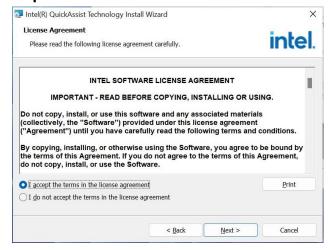
www.avalue.com



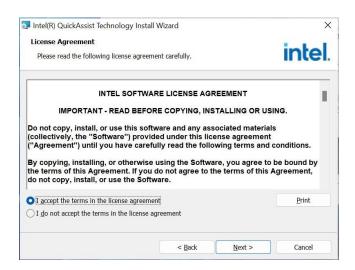
Note: The installation procedures and screen shots in this section are based on Windows 10 operation system.



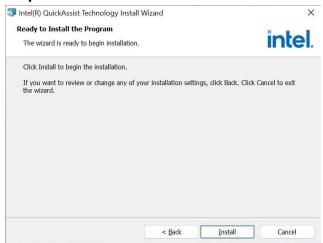
Step 1. Click **Next** to continue installation.



Step 2. Click Next.



Step 3. Click Next.



Step 4. Click Install.



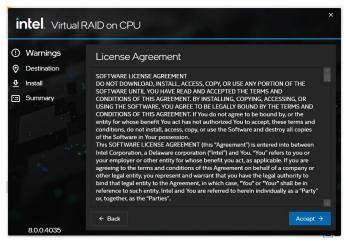
Step 5. Click **Finish** to complete setup.

All drivers can be found on the Avalue Official Website:

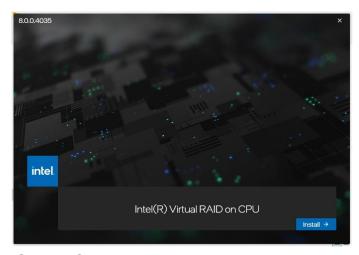
www.avalue.com



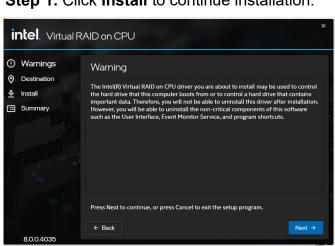
Note: The installation procedures and screen shots in this section are based on Windows 10 operation system.



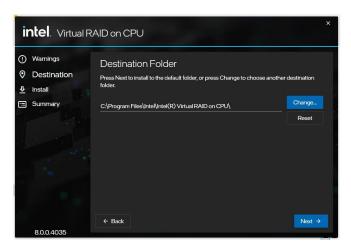
Step 3. Click Accept.



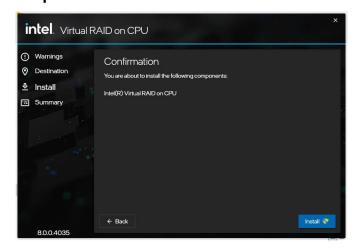
Step 1. Click Install to continue installation.



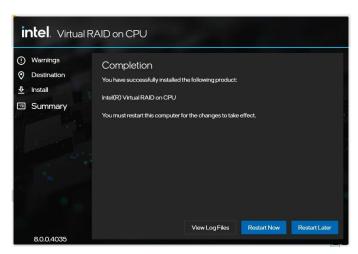
Step 2. Click Next.



Step 4. Click Next.



Step 5. Click Install.



Step 6. Setup completed.

4.BIOS Setup

4.1 Introduction

The BIOS setup program allows users to modify the basic system configuration. In this following chapter will describe how to access the BIOS setup program and the configuration options that may be changed.

4.2 Starting Setup

AMI BIOS™ is immediately activated when you first power on the computer. The BIOS reads the system information contained in the NVRAM and begins the process of checking out the system and configuring it. When it finishes, the BIOS will seek an operating system on one of the disks and then launch and turn control over to the operating system.

While the BIOS is in control, the Setup program can be activated in one of two ways: By pressing <ESC> or immediately after switching the system on, or By pressing the < ESC> or key when the following message appears briefly at the left-top of the screen during the POST (Power On Self Test).

Press <ESC> or to enter SETUP

If the message disappears before you respond and you still wish to enter Setup, restart the system to try again by turning it OFF then ON or pressing the "RESET" button on the system case. You may also restart by simultaneously pressing <Ctrl>, <Alt>, and <Delete> keys.

4.3 Using Setup

In general, you use the arrow keys to highlight items, press <Enter> to select, use the PageUp and PageDown keys to change entries, press <F1> for help and press <Esc> to quit. The following table provides more detail about how to navigate in the Setup program using the keyboard.

Button	Description
\uparrow	Move to previous item
↓	Move to next item
←	Move to the item in the left hand
\rightarrow	Move to the item in the right hand
Esc key	Main Menu Quit and not save changes into NVRAM Status Page Setup Menu and Option Page Setup Menu Exit current page and return to Main Menu
+ key	Increase the numeric value or make changes
- key	Decrease the numeric value or make changes
F1 key	General help, only for Status Page Setup Menu and Option Page Setup Menu
F2 key	Previous Values
F3 key	Optimized defaults
F4 key	Save & Exit Setup

Navigating Through The Menu Bar

Use the left and right arrow keys to choose the menu you want to be in.



Note: Some of the navigation keys differ from one screen to another.

To Display a Sub Menu

Use the arrow keys to move the cursor to the sub menu you want. Then press <Enter>. A ">" pointer marks all sub menus.

4.4 Getting Help

Press F1 to pop up a small help window that describes the appropriate keys to use and the possible selections for the highlighted item. To exit the Help Window press <Esc> or the <Enter> key again.

4.5 In Case of Problems

If, after making and saving system changes with Setup, you discover that your computer no longer is able to boot, the AMI BIOS supports an override to the NVRAM settings which resets your system to its defaults.

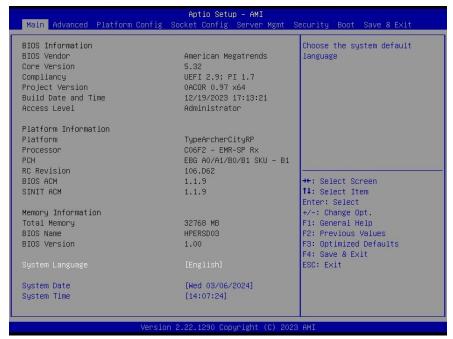
The best advice is to only alter settings which you thoroughly understand. To this end, we strongly recommend that you avoid making any changes to the chipset defaults. These defaults have been carefully chosen by both BIOS Vendor and your systems manufacturer to provide the absolute maximum performance and reliability. Even a seemingly small change to the chipset setup has the potential for causing you to use the override.

4.6 BIOS setup

Once you enter the Aptio Setup Utility, the Main Menu will appear on the screen. The Main Menu allows you to select from several setup functions and exit choices. Use the arrow keys to select among the items and press <Enter> to accept and enter the sub-menu.

4.6.1 Main Menu

This section allows you to record some basic hardware configurations in your computer and set the system clock.



4.6.1.1 System Language

This option allows choosing the system default language.

4.6.1.2 System Date

Use the system date option to set the system date. Manually enter the Month, day and year.

4.6.1.3 System Time

Use the system time option to set the system time. Manually enter the hours, minutes and seconds.

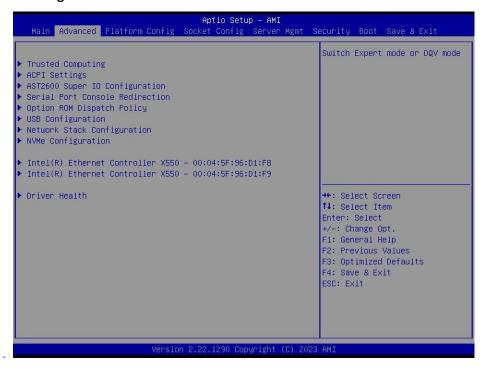


Note: The BIOS setup screens shown in this chapter are for reference purposes only, and may not exactly match what you see on your screen.

Visit the Avalue website (<u>www.avalue.com</u>) to download the latest product and BIOS information.

4.6.2 Advanced Menu

This section allows you to configure your CPU and other system devices for basic operation through the following sub-menus.



4.6.2.1 Trusted Computing



Item	Options	Description
Security Device Support	Disable, Enable [Default]	Enables or Disables BIOS support for security device. O.S. will not show Security Device. TCG EFI protocol and INT1A interface will not be available.

SHA256 PCR Bank	Disabled, Enabled[Default]	Enables or Disables SHA256 PCR Bank.	
SHA384 PCR Bank	Disabled [Default] , Enabled	Enables or Disables SHA384 PCR Bank.	
Pending operation	None [Default] TPM Clear	Schedule an Operation for the Security Device. NOTE: Your Computer will reboot during restart in order to change State of Security Device.	
Physical Presence Spec	1.2	Select to Tell O.S. to support PPI Spec Version 1.2	
Version	1.3 [Default]	or1.3 Note some HCK tests might not support 1.3.	
Device Select	TPM 2.0 Auto [Default]	TPM 1.2 will restrict support to TPM 1.2 devices, TPM 2.0 will restrict support to TPM 2.0 devices, Auto will support both with default set to TPM 2.0 devices if not found, TPM 1.2 devices will be enumerated.	

4.6.2.2 ACPI Settings



Item	Options	Description	
Enable ACPI Auto	Disabled[Default]	Enables or Disables BIOS ACPI Auto Configuration.	
Configuration	Enabled	Eliables of Disables BIOS ACPT Auto Colliguration.	
Enable Hibernation Disabled Enabled[Default]	Disabled	Enables or Disables System ability to Hibernate	
		(OS/S4 Sleep State). This option may not be effective	
	Enabled[Delault]	with some operating systems.	

4.6.2.3 AST2600 Super IO Configuration



Item	Description
Serial Port 1 Configuration	Set Parameters of Serial Port 1 (COMA).
Serial Port 2 Configuration	Set Parameters of Serial Port 2 (COMB).

4.6.2.3.1 Serial Port 1 Configuration



Item	Option	Description
Serial Port	Enabled [Default] , Disabled	Enable or Disable Serial Port (COM).

4.6.2.3.2 Serial Port 2 Configuration



Item	Option	Description
Serial Port	Enabled [Default] , Disabled	Enable or Disable Serial Port (COM).

4.6.2.4 Serial Port Console Redirection



Item	Options	Description
Console Redirection	Disabled[Default],	Console Redirection Enable or Disable.
Console Redirection	Enabled	
Console Redirection EMS	Disabled[Default],	Canada Dadinastian Frahla an Disabla
	Enabled	Console Redirection Enable or Disable.

4.6.2.5 Option ROM Dispatch Policy

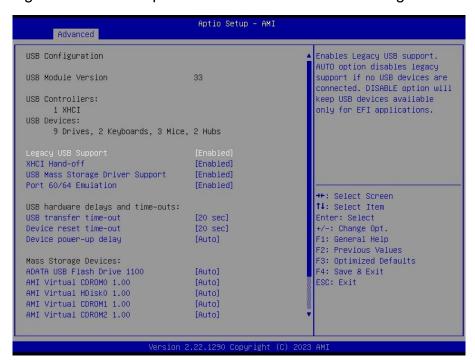


Item	Options	Description
Restore if Failure	Disabled Enabled [Default] ,	If system fails to boot and this option is set to 'Enabled', software will reset settings of this page as well as CSM page to its default values automatically.
Primary Video Ignore	Disabled Enabled [Default] ,	If software will detect that due to the Policy settings. Option ROM of Primary Video Device will not dispatch, it will ignore this device policy settings, and restore it to 'Enable' automatically.
Onboard Mass Storage Controller	Enabled [Default], Disabled	Onboard Device has: UEFI [X] Legacy [X] Embedded ROM(s). VIDx8086; DIDxA1D2 @ s0 Bx0 Dx11 Fx5
Onboard Display Controller	Enabled [Default], Disabled	Onboard Device has: UEFI [X] Legacy [X] Embedded ROM(s). VIDx1A03; DIDx2000 @ s0 BxA Dx0 Fx0

		Onboard Device has:
		UEFI [X]
Onboard Network Controller	Enabled[Default],	Legacy [X]
Onboard Network Controller	Disabled	Embedded ROM(s).
		VIDx8086; DIDx1533
		@ s0 Bx6 Dx0 Fx0
Slat#4 Empty	Enabled[Default],	Enable or Disable Option ROM execution for
Slot#1 Empty	Disabled	selected Slot.
Slot#2 Empty	Enabled[Default],	Enable or Disable Option ROM execution for
Slot#2 Empty	Disabled	selected Slot.
Slot#3 Empty	Enabled[Default],	Enable or Disable Option ROM execution for
Slot#3 Empty	Disabled	selected Slot.
Slot#4 Empty	Enabled[Default],	Enable or Disable Option ROM execution for
Slot#4 Empty	Disabled	selected Slot.
Clat#E Empty	Enabled[Default],	Enable or Disable Option ROM execution for
Slot#5 Empty	Disabled	selected Slot.
Olatic Francis	Enabled[Default],	Enable or Disable Option ROM execution for
Slot#6 Empty	Disabled	selected Slot.
Slot#7 Empty	Enabled[Default],	Enable or Disable Option ROM execution for
Slot#7 Empty	Disabled	selected Slot.

4.6.2.6 USB Configuration

The USB Configuration menu helps read USB information and configures USB settings.



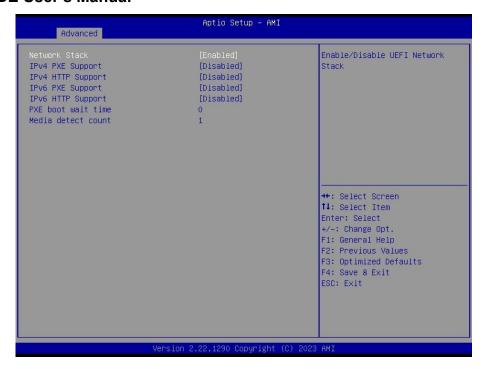
Item	Options	Description
Legacy USB Support	Enabled [Default] , Disabled Auto	Enables Legacy USB support. AUTO option disables legacy support if no USB devices are connected. DISABLE option will keep USB devices available only for EFI applications.
XHCI Hand-off	Enabled[Default],	This is a workaround for OSes without XHCI

User's Manual

		USEI S IVIAITUAI
	Disabled	hand-off support. The XHCI ownership change
		should be claimed by XHCl driver.
HOD Mass Otsassas Daires Occassast	Disabled	Enable/Disable USB Mass Storage Driver
USB Mass Storage Driver Support	Enabled[Default],	Support.
		Enables I/O port 60h/64h emulation support.
Port 60/64 Emulation	Disabled	This should be enabled for the complete USB
Fort 60/64 Emulation	Enabled[Default],	keyboard legacy support for non-USB aware
		OSes.
	1 sec	
USB transfer time-out	5 sec	The time-out value for Control, Bulk, and
USB transfer time-out	10 sec	Interrupt transfers.
	20 sec[Default]	
	10 sec	
Device reset time-out	20 sec[Default]	USB mass storage device Start Unit command
Device reset time-out	30 sec	time-out.
	40 sec	
		Maximum time the device will take before it
	Auto[Defeult]	properly reports itself to the Host Controller.
Device power-up delay	Auto [Default] Manual	'Auto' uses default value: for a Root port it is
	Manual	100 ms, for a Hub port the delay is taken from
		Hub descriptor.
	Auto[Default]	Mass storage device emulation type. 'AUTO'
	Floppy	enumerates devices according to their media
Mass Storage Devices	Forced FDD	format. Optical drives are emulated as
	Hard Disk	'CDROM', drives with no media will be
	CD-ROM	emulated according to a drive type.

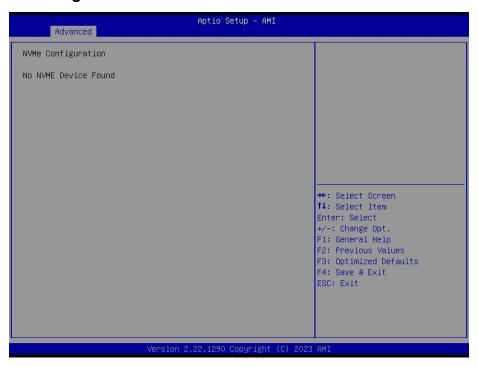
4.6.2.7 Network Stack Configuration



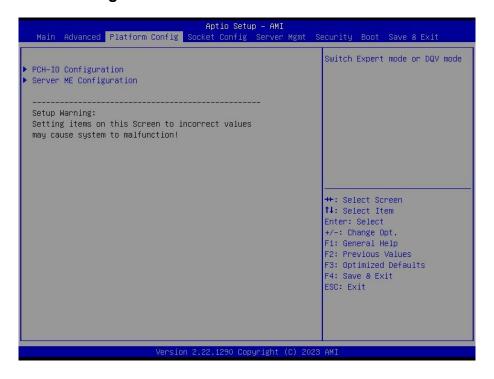


Item	Option	Description
Network stack	Enabled Disabled [Default]	Enable/Disable UEFI Network Stack.
lpv4/6 PXE Support	Enabled Disabled [Default]	Enable/Disable Ipv4/6 PXE boot support. If disabled IPv4/6 PXE boot support will not be available.
lpv4/6 HTTP Support	Enabled Disabled [Default]	Enable/Disable Ipv4/6 HTTP boot support. If disabled, IPv4/6 HTTP boot support will not be available.
PXE boot wait time	0	Wait time to press ESC key to abort the PXE boot.
Media detect count	1	Number of times presence of media will be checked.

4.6.2.8 NVMe Configuration



4.6.3 **Platform Config**

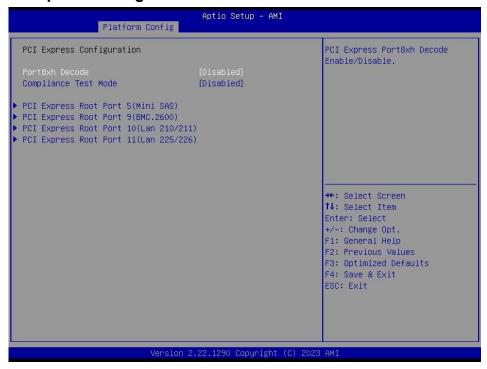


4.6.3.1 PCH-IO Configuration



Item	Option	Description
Serial IRQ Mode	Quiet[Default] Continuous	Configure Serieal IRQ Mode.
State After G3	S0 State S5 State[Default]	Specify what state to go to when power is re-applied after a power failure (G3 state).
Port 80h Redirection	LPC Bus[Default] PCIE Bus	Control where the Port 80h cycles are sent.
Lock PCH Sideband Access	Disabled Enabled [Default]	Lock PCH Sideband access, include SideBand interface lock and SideBand PortID mask for certain end point (e.g. PSFx). The option is invalid if POSTBOOT SAI is set.
Flash Protection Range Registers(FRRR)	Disabled [Default] Enabled	Enable Flash Protection Range Registers.
SPD Write Disable	Disabled Enabled [Default]	Enable/Disable setting SPD Write Disable bit. For sucurity recommendations, SPD write disable bit must be set.

4.6.3.1.1 PCI Express Configuration



Item	Option	Description
Dout Over Donado	Disabled[Default]	PCI Express Port8xh Decode
Port8xh Decode	Enabled	Enable/Disable.
Compliance Test Mode	Disabled[Default]	Enable when using Compliance Load
	Enabled	Board.

4.6.3.1.1.1 PCI Express Root Port 5(Mini SAS)



Item	Option	Description
PCI Express Root Port 5(Mini SAS)	Enabled [Default] , Disabled	Control the PCI Express Root Port.
ASPM	Disabled[Default],	PCI Express Active State Power
ASPIVI	L1	Management settings.
	Disabled[Default]	
L1 Substates	L1.1	DCI Express I.1 Substates settings
LT Substates	L1.2	PCI Express L1 Substates settings.
	L1.1 & L1.2	
DTM	Enabled[Default] ,	Enable/Disable Precision Time
PTM	Disabled	Measurement.
PCIe Speed	Auto[Default]	
	Gen1	Configure DCIe Speed
	Gen2	Configure PCIe Speed.
	Gen3	

4.6.3.1.1.2 PCI Express Root Port 9(BMC.2600)



Item	Option	Description
BCI Express Boot Bort 9/BMC 2600)	Enabled[Default],	Control the DCI Express Boot Bort
PCI Express Root Port 9(BMC. 2600)	Disabled	Control the PCI Express Root Port.
ASPM	Disabled[Default],	PCI Express Active State Power
ASPIN	L1	Management settings.
	Disabled[Default]	
L1 Substates	L1.1	PCI Express L1 Substates settings.
L1 Substates	L1.2	PCI Express L1 Substates settings.
	L1.1 & L1.2	
PTM	Enabled[Default],	Enable/Disable Precision Time
FIM	Disabled	Measurement.

	Auto[Default]	
DCIa Cread	Gen1	Configure DOIs Speed
PCIe Speed	Gen2	Configure PCIe Speed.
	Gen3	

4.6.3.1.1.3 PCI Express Root Port 10(Lan 210/211)



Item	Option	Description
PCI Express Root Port 10(Lan 210/211)	Enabled [Default] , Disabled	Control the PCI Express Root Port.
ASPM	Disabled [Default] ,	PCI Express Active State Power
Activi	L1	Management settings.
	Disabled[Default]	
L1 Substates	L1.1	DCI Everges I.1 Substates settings
Li Substates	L1.2	PCI Express L1 Substates settings.
	L1.1 & L1.2	
DTM	Enabled[Default] ,	Enable/Disable Precision Time
РТМ	Disabled	Measurement.
PCIe Speed	Auto[Default]	
	Gen1	Configure DCIe Speed
	Gen2	Configure PCIe Speed.
	Gen3	

3.6.3.1.1.4 PCI Express Root Port 11(LAN 225/226)

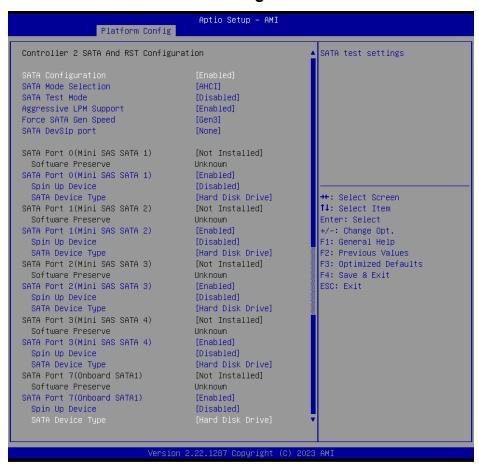


Item	Option	Description
PCI Express Root Port 11(LAN	Enabled[Default] ,	Control the DCI Everges Boot Bort
225/226)	Disabled	Control the PCI Express Root Port.
ASPM	Disabled[Default] ,	PCI Express Active State Power
ASPW	L1	Management settings.
	Disabled[Default]	
L1 Substates	L1.1	PCI Express L1 Substates settings.
Li Substates	L1.2	PCI Express L1 Substates settings.
	L1.1 & L1.2	
PTM	Enabled [Default] ,	Enable/Disable Precision Time
PIVI	Disabled	Measurement.
PCIe Speed	Auto[Default]	
	Gen1	Configure DCIe Speed
	Gen2	Configure PCIe Speed.
	Gen3	

4.6.3.1.2 SATA And RST Configuration



4.6.3.1.2.1 Controller 2 SATA And RST Configuration

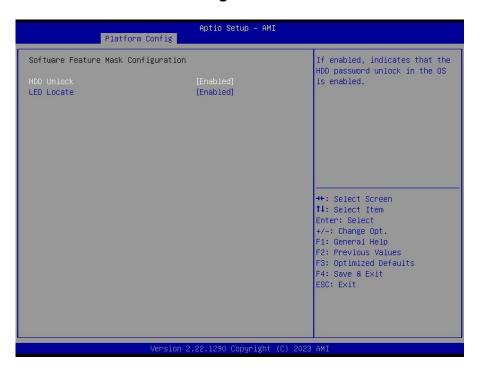


Item	Options	Description
SATA Configuration	Enabled [Default] Disabled,	SATA test settings.
SATA Mode Selection	AHCI [Default] , RAID	Determines how SATA controller(s) operate.
SATA Test Mode	Enabled Disabled [Default]	Test Mode Enable/Disable (Loop Back).
Aggressive LPM Support	Enabled [Default] Disabled	Enable PCH to aggressively enter link power state.
Force SATA Gen Speed	Gen1 Gen2 Gen3[Default]	Changes SATA Gen Speed for port.
SATA DevSlp port	None[Default] Port0 Port1 Port2 Port3 Port4 Port5 Port6 Port7	Enable SATA DevSlp feature for port. It is possible to enable DevSlp for only one port or none.
SATA Port 0(Mini SAS SATA 1)	Disabled Enabled [Default]	Enable or Disable SATA Port.
Spin Up Device	Disabled [Default] Enabled	If enabled for any of ports Staggerred Spin Up will be performed and only the drives which have this option enabled will spin up at boot. Otherwise all drives spin up at boot.
SATA Device Type	Hard Disk Drive [Default] Solid State Drive	Identify the SATA port is connected to Solid State Drive or Hard Disk Drive.
SATA Port 1(Mini SAS SATA 2)	Disabled Enabled [Default]	Enable or Disable SATA Port.
Spin Up Device	Disabled [Default] Enabled	If enabled for any of ports Staggerred Spin Up will be performed and only the drives which have this option enabled will spin up at boot. Otherwise all drives spin up at boot.
SATA Device Type	Hard Disk Drive[Default] Solid State Drive	Identify the SATA port is connected to Solid State Drive or Hard Disk Drive.
SATA Port 2(Mini SAS SATA 3)	Disabled Enabled [Default]	Enable or Disable SATA Port.
Spin Up Device	Disabled [Default] Enabled	If enabled for any of ports Staggerred Spin Up will be performed and only the drives which have this option enabled will

User's Manual

		USEI S IVIAITUAI
		spin up at boot. Otherwise all drives spin up at boot.
SATA Device Type	Hard Disk Drive [Default] Solid State Drive	Identify the SATA port is connected to Solid State Drive or Hard Disk Drive.
SATA Port 3(Mini SAS SATA 4)	Disabled Enabled [Default]	Enable or Disable SATA Port.
Spin Up Device	Disabled [Default] Enabled	If enabled for any of ports Staggerred Spin Up will be performed and only the drives which have this option enabled will spin up at boot. Otherwise all drives spin up at boot.
SATA Device Type	Hard Disk Drive [Default] Solid State Drive	Identify the SATA port is connected to Solid State Drive or Hard Disk Drive.
SATA Port 7(Onboard SATA 1)	Disabled Enabled [Default]	Enable or Disable SATA Port.
Spin Up Device	Disabled [Default] Enabled	If enabled for any of ports Staggerred Spin Up will be performed and only the drives which have this option enabled will spin up at boot. Otherwise all drives spin up at boot.
SATA Device Type	Hard Disk Drive[Default] Solid State Drive	Identify the SATA port is connected to Solid State Drive or Hard Disk Drive.

4.6.3.1.2.2 Software Feature Mask Configuration for Controller 2



Item	Options	Description
HDD Unlock	Disabled,	If enabled, indicates that the HDD password
HDD Officek	Enabled[Default]	unlock in the OS is enabled.
LED Locate Disab	Disabled	If enabled, indicates that the LED/SGPIO
	,	hardware is attached and ping to locate
	Enabled[Default]	feature is enabled on the OS.

4.6.3.1.3 USB Configuration



Item	Options	Description
	Disabled, Enabled [Default]	Select 'Disabled' for pin-based debug. If pin-based
USB Overcurrent		debug is enabled but USB overcurrent is not
		disabled, USB DbC does not work.
	Disable [Default] Select Per-Pin	Selectively Enable/Disable the corresponding USB
USB Port Disable Override		port from reporting a Device Connection to the
		controller.

4.6.3.1.4 HD Audio Configuration



Item	Options	Description
HD Audio	Disabled, Enabled [Default]	Control Detection of the HD-Audio device. Disabled=HDA will be unconditionally disabled
		Enabled=HDA will be unconditionally enabled.

4.6.3.2 **Server ME Configuration**



Item	Option	Description
Altitude	8000	The altitude of the platform location above the sea level, expressed in meters. The hex number is decoded as 2's complement signed integer. Provide the 8000h value if the

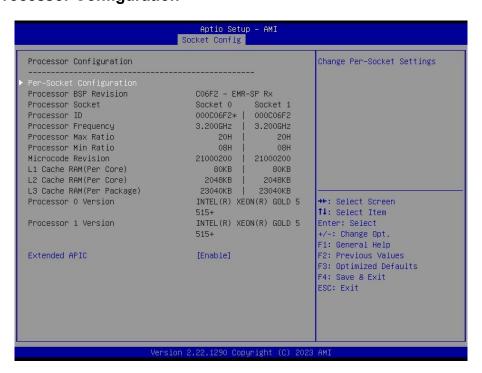
		altitude is unknown.
MCTP Bus Owner	0	MCTP bus owner location on PCle: [15:8] bus, [7:3] device, [2:0] function. If all zeros sending bus owner is disabled.

4.6.4 Socket Config



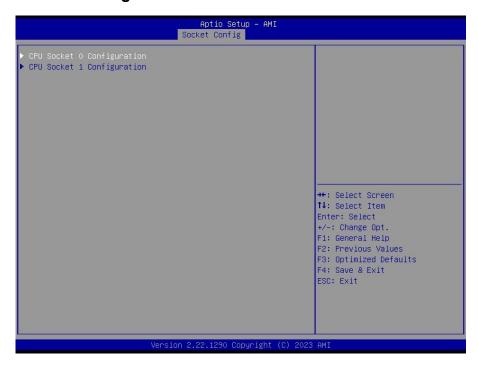
Item	Options	Description
Expert Mode (Socket config)	DQV mode[Default]	Switch Expert mode or DQV mode.
	Expert mode	Switch Expert mode of DQV mode.

4.6.4.1 Processor Configuration

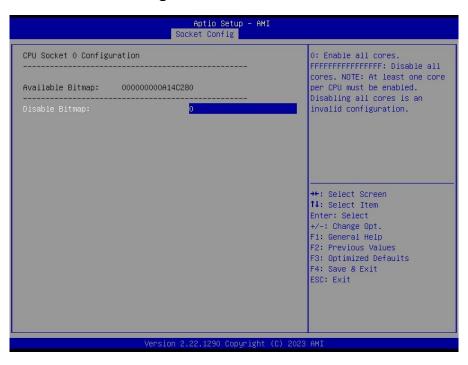


Item	Option	Description
Extended APIC	Disable Enable [Default]	Enable/disable extended APIC support. Note: When enabled, VT-d_Interrupt Remapping will be automatically enabled.

4.6.4.1.1 Per-Socket Configuration



CPU Socket 0 Configuration 4.6.4.1.1.1



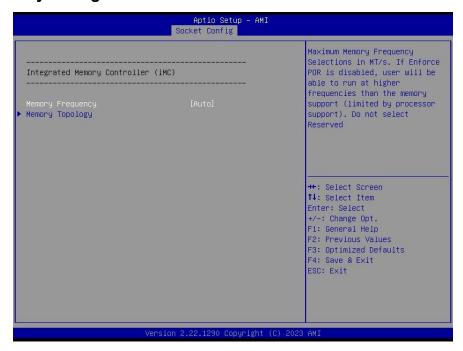
Item	Option	Description
Disable Bitmap:	0	0: Enable all cores. FFFFFFFFFFFFFFFF: Disable all cores. NOTE: AT least one core per CPU must be enabled. Disabling all cores is an invalid configuration.

4.6.4.1.1.2 CPU Socket 1 Configuration



Item	Option	Description
		0: Enable all cores. FFFFFFFFFFFFFF: Disable
Disable Bitmap:	0	all cores. NOTE: AT least one core per CPU must be
Disable Bitiliap.		enabled. Disabling all cores is an invalid
		configuration.

Memory Configuration 4.6.4.2

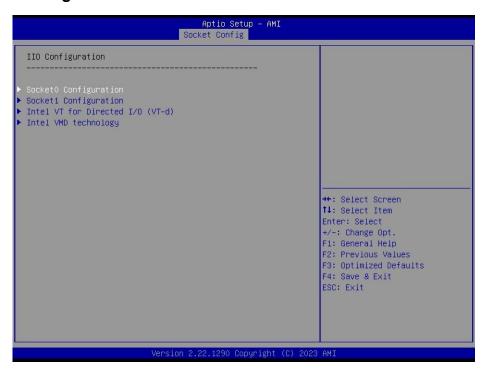


Item	Option	Description
Memory Frequency	Auto[Default] 3200 3600 4000 4400 4800 5200	Maximum Memory Frequency Selections in MT/s. If Enforce POR is disabled, user will be able to run at higher frequencies than the memory suppot (limited by processor support). Do not select Reserved.
	5600	

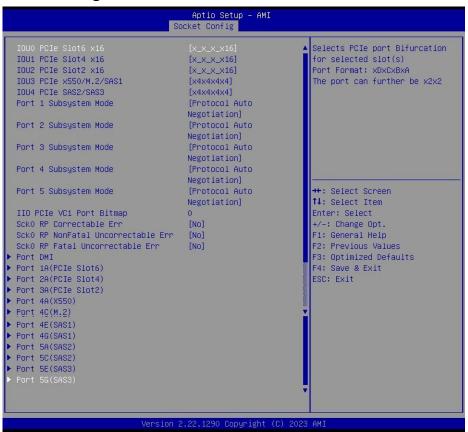
4.6.4.2.1 Memory Topology



4.6.4.3 IIO Configuration



4.6.4.3.1 Socket0 Configuration



Item	Options	Description
IOU0 PCIe Slot6 x16	Auto x4x4x4x4	Selects PCIe port Bifurcation for selected
1000 Fole Sloto X10	x4x4x_x8	slot(s) Port Format: xDxCxBxA The port

User's Manual

	T	User's Manual
	x_x8x4x4	can further be x2x2.
	x_x8x_x8	
	x_x_x_x16[Default]	
	x2x2x4x_x8	
	x4x2x2x_x8	
	x_x8x2x2x4	
	x2x2x4x4x4	
	x4x2x2x4x4	
	x4x4x2x2x4	
	x2x2x2x2x_x8	
	x2x2x2x2x4x4	
	x2x2x4x2x2x4	
	x4x2x2x2x2x4	
	x2x2x2x2x2x4	
	x_x8x4x2x2	
	x4x4x4x2x2	
	x_x8x2x2x2x2	
	x2x2x4x4x2x2	
	x4x2x2x4x2x2	
	x4x4x2x2x2x2	
	x2x2x2x2x4x2x2	
	x2x2x4x2x2x2	
	x4x2x2x2x2x2	
	x2x2x2x2x2x2x2	
	Auto	
	x4x4x4x4	
	x4x4x_x8	
	x_x8x4x4	
	x_x8x_x8	
	x_x_x_x16[Default]	
	x2x2x4x_x8	
	x4x2x2x_x8	
	x_x8x2x2x4	
	x2x2x4x4x4	
	x4x2x2x4x4	
	x4x4x2x2x4	Selects PCIe port Bifurcation for selected
	x2x2x2x2x_x8	·
IOU1 PCIe Slot4 x16	x2x2x2x2x4x4	slot(s) Port Format: xDxCxBxA The port
	x2x2x4x2x2x4	can further be x2x2.
	x4x2x2x2x2x4	
	x2x2x2x2x2x4	
	x_x8x4x2x2	
	x4x4x4x2x2	
	x_x8x2x2x2x2	
	x2x2x4x4x2x2	
	x4x2x2x4x2x2	
	x4x4x2x2x2x2	
	x2x2x2x2x4x2x2	
	x2x2x4x2x2x2x2	
	x4x2x2x2x2x2	
	x2x2x2x2x2x2x2	
	Auto	
	x4x4x4x4	
	x4x4x_x8	Selects PCIe port Bifurcation for selected
IOUG BOL OL IS	x_x8x4x4	·
IOU2 PCle Slot2 x16	x_x8x_x8	slot(s) Port Format: xDxCxBxA The port
	x_x_x_x16[Default]	can further be x2x2.
	x2x2x4x_x8	
	x4x2x2x_x8	
	x_x8x2x2x4	

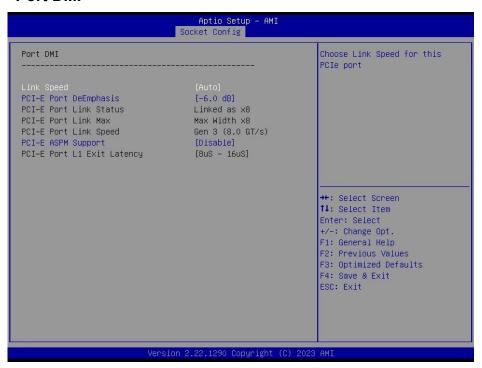
HPM-ERSDE User's I	vianuai	
	x2x2x4x4x4	
	x4x2x2x4x4	
	x4x4x2x2x4	
	x2x2x2x2x_x8	
	x2x2x2x2x4x4	
	x2x2x4x2x2x4	
	x4x2x2x2x4	
	x2x2x2x2x2x4	
	x_x8x4x2x2	
	x4x4x4x2x2	
	x_x8x2x2x2x2	
	x2x2x4x4x2x2	
	x4x2x2x4x2x2	
	x4x4x2x2x2x2	
	x2x2x2x2x4x2x2	
	x2x2x4x2x2x2x2	
	x4x2x2x2x2x2	
	x2x2x2x2x2x2x2	
	Auto	
	x4x4x4x4[Default]	
	x4x4x_x8	
	x_x8x4x4	
	x_x8x_x8	
	x_x_x_x16	
	x2x2x4x_x8	
	x4x2x2x_x8	
	x_x8x2x2x4	
	x2x2x4x4x4	
	x4x2x2x4x4	
	x4x2x2x4x4 x4x4x2x2x4	
		Selects PCIe port Bifurcation for selected
IOU3 PCIe	x2x2x2x2x_x8	
x550/M.2/SAS1	x2x2x2x2x4x4	slot(s) Port Format: xDxCxBxA The port
	x2x2x4x2x2x4	can further be x2x2.
	x4x2x2x2x2x4	
	x2x2x2x2x2x4	
	x_x8x4x2x2	
	x4x4x4x2x2	
	x_x8x2x2x2x2	
	x2x2x4x4x2x2	
	x4x2x2x4x2x2	
	x4x4x2x2x2x2	
	x2x2x2x2x4x2x2	
	x2x2x4x2x2x2x2	
	x4x2x2x2x2x2	
	x2x2x2x2x2x2x2	
	Auto	
	x4x4x4x4[Default]	
	x4x4x x8	
	x_x8x4x4	
	x_x8x_x8	
	x_x_x_x16	
		Calcata DOIs most Differentian for calcatad
		Selects PCIe port Bifurcation for selected
IUIN BUIV EVESIEVES	x2x2x4x_x8	·
IOU4 PCIe SAS2/SAS3	x2x2x4x_x8 x4x2x2x_x8	slot(s) Port Format: xDxCxBxA The port
IOU4 PCIe SAS2/SAS3	x2x2x4x_x8 x4x2x2x_x8 x_x8x2x2x4	·
IOU4 PCIe SAS2/SAS3	x2x2x4x_x8 x4x2x2x_x8 x_x8x2x2x4 x2x2x4x4x4	slot(s) Port Format: xDxCxBxA The port
IOU4 PCIe SAS2/SAS3	x2x2x4x_x8 x4x2x2x_x8 x_x8x2x2x4 x2x2x4x4x4 x4x2x2x4x4	slot(s) Port Format: xDxCxBxA The port
IOU4 PCIe SAS2/SAS3	x2x2x4x_x8 x4x2x2x_x8 x_x8x2x2x4 x2x2x4x4x4 x4x2x2x4x4 x4x2x2x4x4	slot(s) Port Format: xDxCxBxA The port
IOU4 PCIe SAS2/SAS3	x2x2x4x_x8 x4x2x2x_x8 x_x8x2x2x4 x2x2x4x4x4 x4x2x2x4x4 x4x4x2x2x4x4 x2x2x2x2	slot(s) Port Format: xDxCxBxA The port
IOU4 PCIe SAS2/SAS3	x2x2x4x_x8 x4x2x2x_x8 x_x8x2x2x4 x2x2x4x4x4 x4x2x2x4x4 x4x2x2x4x4	slot(s) Port Format: xDxCxBxA The port

User's Manual

		User's Manual
	x4x2x2x2x2x4 x2x2x2x2x2x4 x_x8x4x2x2 x4x4x4x2x2 x_x8x2x2x2x2 x2x2x4x4x2x2 x4x2x2x4x2x2 x4x4x2x2x2x2	
	x2x2x2x2x2x2x2	0.1.1701.0.11111
		Select PCIe Subsystem Mode for
		selected slot(s) Gen4: Gen4 controller
Port 1 Subsystem Mode	Gen5 Protocol Auto Negotiation[Default]	only Gen5: Gen5 with or without mix
	1 1000001 Auto Negotiation[Delacit]	mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
		Select PCIe Subsystem Mode for
		selected slot(s) Gen4: Gen4 controller
Port 2 Subsystem Mode	Gen5 Protocol Auto Negotiation[Default]	only Gen5: Gen5 with or without mix
	Protocol Auto Negotiation[Delauit]	mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
	Gen5 Protocol Auto Negotiation [Default]	Select PCIe Subsystem Mode for
		selected slot(s) Gen4: Gen4 controller
Port 3 Subsystem Mode		only Gen5: Gen5 with or without mix
		mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
		Select PCIe Subsystem Mode for
	_	selected slot(s) Gen4: Gen4 controller
Port 4 Subsystem Mode	Gen5 Protocol Auto Negotiation[Default]	only Gen5: Gen5 with or without mix
		mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
		Select PCIe Subsystem Mode for
		selected slot(s) Gen4: Gen4 controller
Port 5 Subsystem Mode	Gen5 Protocol Auto Negotiation[Default]	only Gen5: Gen5 with or without mix
	Protocol Auto Negotiation[Default]	mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
IIO PCIe VC1 Port Bitmap	0	Enable/Disable PCle Port VC1 support.
•	Port 0 is allocated to DMI or DMI as PCIe.	

TII W ENODE OSCI S II	lallaal	
		Port 0 bit will have no effect in DMI mode.
		0-VC1 support disabled. 1-VC1 support
		enabled. Example: bit 0= IIO PCle Port
		0bit n = IIO PCIe Portn.
Sck0 RP Correctable Err	No [Default] Yes	Applies to root ports only. Enabled
		interrupt on correctable errors.
Sck0 RP NonFatal	No[Default]	Applies to root ports only. Enabled
Uncorrectable Err	Yes	interrupt on a non-fatal error.
Sck0 RP Fatal	RP Fatal No[Default]	Applies to root ports only. Enabled
Uncorrectable Err	Yes	MSI/INTx interrupt on fatal errors.

4.6.4.3.1.1 Port DMI



Item	Option	Description
	Auto[Default]	
	Gen 1 (2.5 GT/s)	
Link Speed	Gen 2 (5 GT/s)	Change Link Speed for this DCIs port
Link Speed	Gen 3 (8 GT/s)	Choose Link Speed for this PCIe port.
	Gen 4 (16 GT/s)	
	Gen 5 (32 GT/s)	
DCI E Bowt DoEmphosio	-6.0 dB[Default]	De-Emphais control (LNKCON2[6]) for this PCIe
PCI-E Port DeEmphasis	-3.5 dB	port.
DOLE ACOM Commont	Disabled[Default]	This option can disable ASPM support in a PCle
PCI-E ASPM Support	Auto	root port. 'Auto' keeps hardware default.

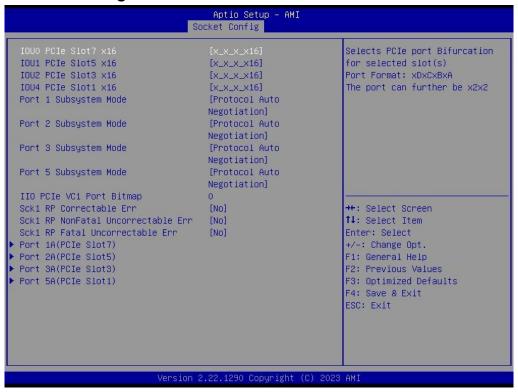
4.6.4.3.1.2 Port 1A(PCIe Slot6), Port 2A(PCIe Slot4), Port 3A(PCIe Slot2), Port 4A(X550), Port 4C(M.2), Port 4E(SAS1), Port 4G(SAS1), Port 5A(SAS2), Port 5C(SAS2), Port 5E(SAS3), Port 5G(SAS3)



Item	Option	Description
		In auto mode the BIOS will remove the EXP port if
	Auto[Default]	there is no device or errors on that device and the
PCI-E Port	No	device is not HP capable. Enable/Disable is used to
	Yes	enable/disable the port and expose/hide its CFG
		space.
PCI-E Port Link Disable	No[Default]	This option disables the link so that the no training
PCI-E POIT LINK DISABle	Yes	occurs but the CFG space is still active.
	Auto[Default]	
	Gen 1 (2.5 GT/s)	
Link Speed	Gen 2 (5 GT/s)	Change Link Speed for this DCIs part
Link Speed	Gen 3 (8 GT/s)	Choose Link Speed for this PCIe port.
	Gen 4 (16 GT/s)	
	Gen 5 (32 GT/s)	
	Auto[Default]	
	x1	
Override Max Link Width	x2	Override the max link width that was set by
Override wax Link width	x4	bifurcation.
	x8	
	x16	
DCI E Dout DoEmphosis	-6.0 dB[Default]	De-Emphais control (LNKCON2[6]) for this PCle
PCI-E Port DeEmphasis	-3.5 dB	port.
Data Link Footure Evokanas	Disable	Enable/Disable data link feature negotiation in the
Data Link Feature Exchange	Enable[Default]	Data Link Feature Capabilities (DLFCAP) register.
PCI-E Port MPSS	128B	Configure Max Payload Size Supported in PCIe
PCI-E POIL WIP33	256B	Device Capabilities register. 'Auto' keeps hardware

	5400	1.6.16	
	512B	default.	
	Auto[Default]		
PCI-E ASPM Support	Disabled[Default]	This option can disable ASPM support in a PCle	
1 OI-E ASI W Support	Auto	root port. 'Auto' keeps hardware default.	
	Disable		
PCI-E Detect Wait Time	500ms	Set PCIe port TxRx detect polling.	
	Auto[Default]		
Compliance Mode	No[Default]	Enable/Disable Compliancer Mode for this PCle	
	Yes	port.	
MOTE	No	Enable/Disable MCTD	
МСТР	Yes[Default]	Enable/Disable MCTP.	
Equalization Bypass To	Disable	Equalization Bypass To Highest Rate Support	
Highest Rate	Enable[Default]	Enable/Disable.	
CVI Duift Buffor	Disable[Default]	Enable/Disable CXL Drift Buffer if there is a	
CXL Drift Buffer	Enable	common reference clock.	

4.6.4.3.2 Socket1 Configuration



Item	Options	Description
IOU0 PCIe Slot7 x16	Auto x4x4x4x4 x4x4x_x8 x_x8x4x4 x_x8x_x8 x_x_x_x16[Default] x2x2x4x_x8 x4x2x2x_x8 x_x8x2x2x4 x2x2x4x4 x4x2x2x4x4 x4x4x2x2x4 x2x2x2x4 x2x2x2x4 x2x2x2x4 x2x2x2x4	Selects PCIe port Bifurcation for selected slot(s) Port Format: xDxCxBxA The port can further be x2x2.

User's Manual

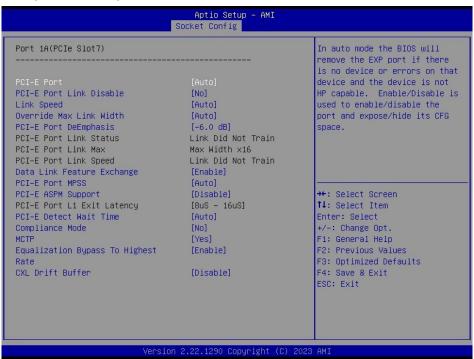
	,	User's Manual
	x2x2x2x4x4	
	x2x2x4x2x2x4	
	x4x2x2x2x2x4	
	x2x2x2x2x2x4	
	x_x8x4x2x2	
	x4x4x4x2x2	
	x_x8x2x2x2x2	
	x2x2x4x4x2x2	
	x4x2x2x4x2x2	
	x4x4x2x2x2x2	
	x2x2x2x2x4x2x2	
	x2x2x4x2x2x2x2	
	x4x2x2x2x2x2	
	x2x2x2x2x2x2x2x2	
	Auto	
	x4x4x4x4	
	x4x4x_x8	
	x_x8x4x4	
	x_x8x_x8	
	x_x_x_x16[Default]	
	x2x2x4x_x8	
	x4x2x2x_x8	
	x_x8x2x2x4	
	x2x2x4x4x4	
	x4x2x4x4x4	
	x4x2x2x4x4 x4x4x2x2x4	
	x2x2x2x2x_x8	Selects PCIe port Bifurcation for selected
IOU1 PCIe Slot5 x16	x2x2x2x2x_x0 x2x2x2x2x4x4	slot(s) Port Format: xDxCxBxA The port
IOUT PCIE SIOIS X 16	x2x2x2x4x4 x2x2x4x2x2x4	Siot(s) Fort Format. XDXCXBXA The port
	x4x2x2x2x4 x4x2x2x2x2x4	can further be x2x2.
	x2x2x2x2x2x4 x2x2x2x2x2x4	
	x_x8x4x2x2 x4x4x4x2x2	
	x_x8x2x2x2x2 x2x2x4x4x2x2	
	x2x2x4x4x2x2 x4x2x2x4x2x2	
	x4x4x2x2x2x2	
	x2x2x2x2x4x2x2	
	x2x2x4x2x2x2x2	
	x4x2x2x2x2x2	
	x2x2x2x2x2x2x2	
	Auto	
	x4x4x4x4	
	x4x4x_x8	
	x_x8x4x4	
	x_x8x_x8	
	x_x_x_x16[Default]	
	x2x2x4x_x8	
	x4x2x2x_x8	Selects PCIe port Bifurcation for selected
	x_x8x2x2x4	·
IOU2 PCIe Slot3 x16	x2x2x4x4x4	slot(s) Port Format: xDxCxBxA The port
	x4x2x2x4x4	can further be x2x2.
	x4x4x2x2x4	,
	x2x2x2x2x_x8	
	x2x2x2x2x4x4	
	x2x2x4x2x2x4	
	x4x2x2x2x4	
	x2x2x2x2x2x4	
1	x x8x4x2x2	
	x4x4x4x2x2	

HPM-ERSDE User's N		T
	x_x8x2x2x2x2	
	x2x2x4x4x2x2 x4x2x2x4x2x2	
	x4x2x2x4x2x2 x4x4x2x2x2x2x2	
	x2x2x2x2x4x2x2	
	x2x2x4x2x2x2x2	
	x4x2x2x2x2x2	
	x2x2x2x2x2x2x2	
	Auto	
	x4x4x4x4	
	x4x4x_x8 x_x8x4x4	
	x_x8x_x8	
	x_x_x_x16[Default]	
	x2x2x4x_x8	
	x4x2x2x_x8	
	x_x8x2x2x4	
	x2x2x4x4x4 x4x2x2x4x4	
	x4x2x2x4x4 x4x4x2x2x4	
	x2x2x2x2x x8	Selects PCIe port Bifurcation for selected
IOU4 PCIe Slot1 x16	x2x2x2x2x4x4	slot(s) Port Format: xDxCxBxA The port
	x2x2x4x2x2x4	can further be x2x2.
	x4x2x2x2x4	Carriartici De XZXZ.
	x2x2x2x2x2x4	
	x_x8x4x2x2 x4x4x4x2x2	
	x x8x2x2x2x2	
	x2x2x4x4x2x2	
	x4x2x2x4x2x2	
	x4x4x2x2x2x2	
	x2x2x2x2x4x2x2 x2x2x4x2x2x2x2	
	x2x2x4x2x2x2x2 x4x2x2x2x2x2x2	
	x2x2x2x2x2x2x2x2	
		Select PCIe Subsystem Mode for
		selected slot(s) Gen4: Gen4 controller
Port 1 Subsystem Mode	Gen5	only Gen5: Gen5 with or without mix
Total Guadyotom moud	Protocol Auto Negotiation[Default]	mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
		Select PCIe Subsystem Mode for
		selected slot(s) Gen4: Gen4 controller
Port 2 Subsystem Mode	Gen5	only Gen5: Gen5 with or without mix
	Protocol Auto Negotiation[Default]	mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
	ort 3 Subsystem Mode	Select PCIe Subsystem Mode for
Port 3 Subsystem Mode		selected slot(s) Gen4: Gen4 controller
. cit o cuboyotom mouc	Protocol Auto Negotiation[Default]	only Gen5: Gen5 with or without mix
		mode Auto: Auto select Force CXL: There

User's Manual

		Cool o mandar
		is no training discovery, the attached
		device must also supports this mode.
		Select PCIe Subsystem Mode for
		selected slot(s) Gen4: Gen4 controller
Don't F Cubouctom Mode	Gen5	only Gen5: Gen5 with or without mix
Port 5 Subsystem Mode	Protocol Auto Negotiation[Default]	mode Auto: Auto select Force CXL: There
		is no training discovery, the attached
		device must also supports this mode.
IIO PCIe VC1 Port Bitmap	0	Enable/Disable PCIe Port VC1 support.
		Port 0 is allocated to DMI or DMI as PCIe.
		Port 0 bit will have no effect in DMI mode.
		0-VC1 support disabled. 1-VC1 support
		enabled. Example: bit 0= IIO PCle Port
		0bit n = IIO PCIe Portn.
Calif DD Carractable Fra	No[Default]	Applies to root ports only. Enabled
Sck1 RP Correctable Err	Yes	interrupt on correctable errors.
Sck1 RP NonFatal	No [Default] Yes	Applies to root ports only. Enabled
Uncorrectable Err		interrupt on a non-fatal error.
Sck1 RP Fatal	110[Boldant]	Applies to root ports only. Enabled
Uncorrectable Err		MSI/INTx interrupt on fatal errors.
Sck1 RP Fatal	No[Default]	Applies to root ports only. Enabled

4.6.4.3.2.1 Port 1A(PCle Slot7), Port 2A(PCle Slot5), Port 3A(PCle Slot3), Port 5A(PCle Slot1)



Item	Option	Description
		In auto mode the BIOS will remove the EXP port if
	Auto[Default]	there is no device or errors on that device and the
PCI-E Port	No	device is not HP capable. Enable/Disable is used to
	Yes	enable/disable the port and expose/hide its CFG
		space.
	No[Default]	This option disables the link so that the no training
PCI-E Port Link Disable	Yes	occurs but the CFG space is still active.
	Auto[Default]	·
	Gen 1 (2.5 GT/s)	
L'ala Cara d	Gen 2 (5 GT/s)	
Link Speed	Gen 3 (8 GT/s)	Choose Link Speed for this PCIe port.
	Gen 4 (16 GT/s)	
	Gen 5 (32 GT/s)	
	Auto[Default]	
	x1	
Overwide May Link Width	x2	Override the max link width that was set by
Override Max Link Width	x4	bifurcation.
	x8	
	x16	
PCI-E Port DeEmphasis	-6.0 dB[Default]	De-Emphais control (LNKCON2[6]) for this PCle
FOI-E FOIT DELITIPITASIS	-3.5 dB	port.
Data Link Feature Exchange	Disable	Enable/Disable data link feature negotiation in the
Data Ellik i catale Exchange	Enable[Default]	Data Link Feature Capabilities (DLFCAP) register.
	128B	Configure Max Payload Size Supported in PCle
PCI-E Port MPSS	256B	Device Capabilities register. 'Auto' keeps hardware
1 01 2 1 010 1111 00	512B	default.
	Auto[Default]	default.
PCI-E ASPM Support	Disabled[Default]	This option can disable ASPM support in a PCle
TOTE ACT III Cupport	Auto	root port. 'Auto' keeps hardware default.
	Disable	
PCI-E Detect Wait Time	500ms	Set PCIe port TxRx detect polling.
	Auto[Default]	
Compliance Mode	No[Default]	Enable/Disable Compliancer Mode for this PCle
Compilation mode	Yes	port.
MCTP	No	Enable/Disable MCTP.
	Yes[Default]	
Equalization Bypass To	Disable	Equalization Bypass To Highest Rate Support
Highest Rate	Enable[Default]	Enable/Disable.
CXL Drift Buffer	Disable [Default]	Enable/Disable CXL Drift Buffer if there is a
CAL DITIL DUTIER	Enable	common reference clock.

4.6.4.3.3 Intel VT for Directed I/O (VT-d)



Item	Options	Description
	T for Directed I/O Enable[Default] Disable	Eneble/Disable Intel Virtualization Technology for
Intel VI for Directed I/O		Directed I/O (VT-d) by reporting the I/O device
inter vir for Directed I/O		assignment to VMM through DMAR ACPI Tables. To
		disable VT-d, X2APIC must also be disabled.

4.6.4.3.4 Intel VMD technology



4.6.4.3.4.1 Intel VMD for Volume Management Device on Socket 0

	Aptio Setup – AMI Socket Config	
VMD Config for IOU O(PCIe Slot6) Enable/Disable VMD	[Disable]	Enable/Disable VMD in this Stack.
VMD Config for IOU 1(PCIe Slot4) Enable/Disable VMD	[Disable]	
VMD Config for IOU 2(PCIe Slot2) Enable/Disable VMD	[Disable]	
VMD Config for IOU 3 Enable/Disable VMD	[Disable]	
VMD Config for IOU 4 Enable/Disable VMD	[Disable]	++: Select Screen †1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit
Version	2.22.1290 Copyright	(C) 2023 AMI

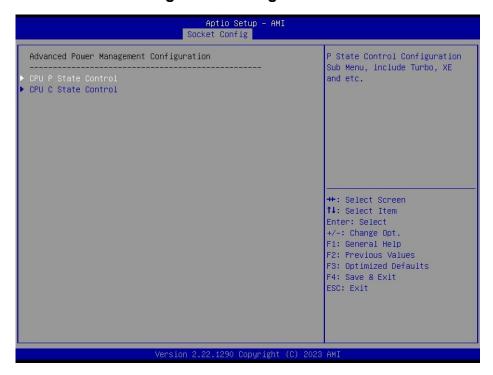
Item	Option	Description
Enable/Disable VMD	Disable[Default]	Enable/Disable VMD in this Stack.
Litable/Disable VIVID	Enable	Eliable/Disable VIVID III tilis Stack.

4.6.4.3.4.2 Intel VMD for Volume Management Device on Socket 1



Item	Option	Description	
Enable/Disable VMD	Disable[Default]	Enable/Disable VMD in this Stack.	
Litable/Disable VIVID	Enable	Litable/Disable VIVID III tills Stack.	

4.6.4.4 Advanced Power Management Configuration



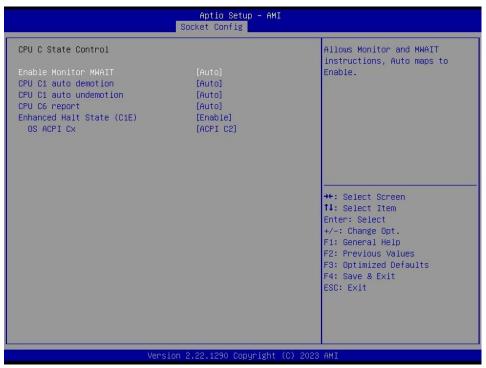
4.6.4.4.1 CPU P State Control



Item	Option	Description
Activate SST-BF	Disable [Default] Enable	This Option allows SST-BF to be enabled. NOTE: HWP Native Mode is a pre-requisite for enabling SST-BF; HWP Native Mode with No Legacy is a pre-requisite for configuring SST-BF.
SpeedStep (Pstates)	Disable	Enable/Disable EIST (P-States).

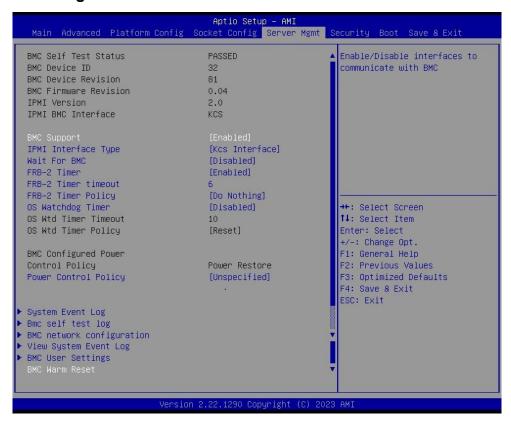
	Enable [Default]	
EIST PSD Function	HW_ALL [Default] SW_ALL	Choose HW_ALL/SW_ALL in _PSD return.
Boot performance mode	Max Performance[Default] Max Efficient Set by Intel Node Manager	Select the performance state that the BIOS will set before OS hand off.
Energy Efficient Turbo	Enable [Default] Disable	Energy Efficient Turbo Disable, MSR 0x1FC[19].
Turbo Mode	Disable Enable [Default]	Enable/Disable processor Turbo Mode (requires EMTTM enabled too).
CPU Flex Ratio Override	Disable [Default] Enable	Enable/Disable CPU Flex Ratio Programming.

4.6.4.4.2 CPU C State Control



Item	Option	Description
Enable Monitor MWAIT	Disable Enable Auto [Default]	Allows Monitor and MWAIT instructions, Auto maps to Enable.
CPU C1 auto demotion	Disable Enable [Default]	Allows CPU to automatically demote to C1. Takes effect after reboot.
CPU C1 auto undemotion	Disable Enable [Default]	Allows CPU to automatically undemote from C1. Takes effect after reboot.
CPU C6 report	Disable Enable Auto [Default]	Enable/Disable CPU C6(ACPI C3) report to OS, Auto maps to enable.
Enhanced Halt State (C1E)	Disable Enable [Default]	Core C1E auto promotion Control. Takes effect after reboot. Will be enforced to enable when Optimized Power Mode is enabled.
OS ACPI Cx	ACPI C2 [Default] ACPI C3	Report CC3/CC6 to OS ACPI C2 or ACPI C3.

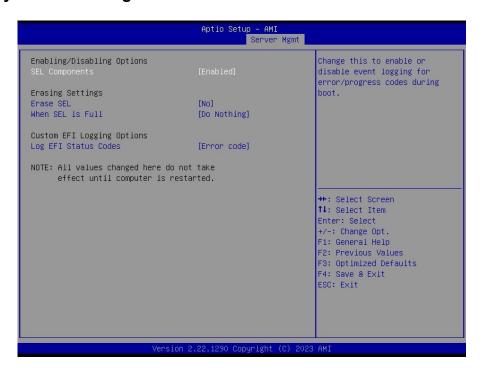
4.6.5 Server Mgmt



Item	Options	Description
BMC Support	Enabled [Default] Disabled	Enable/Disable interfaces to communicate with BMC.
IPMI Interface Type	Kcs Interface[Default] Ssif Interface Ipmb Interface Usb Interface Oem1 Interface Oem2 Interface	Type of Interface to communicate BMC from HOST.
Wait For BMC	Enabled Disabled [Default]	Wait For BMC response for specified time out. BMC starts at the same time when BIOS starts during AC power ON. It takes around 30 seconds to initialize Host to BMC interfaces.
FRB-2 Timer	Enabled [Default] Disabled	Enable or Disable FRB-2 time (POST timer).
FRB-2 Timer timeout	6	Enter value Between 3 to 6 min for FRB-2 Timer Expiration value.
FRB-2 Timer Policy	Do Nothing [Default] Reset Power Down Power Cycle	Configure how the system should respond if the FRB-2 Timer expires. Not available if FRB-2 Timer is disabled.
OS Watchdog Timer	Enabled Disabled [Default]	If enabled, starts a BIOS timer which can only be shut off by Management Software after the OS loads. Helps determine that the OS successfully loaded or follows the OS Boot Watchdog Timer policy.

	Do Not PowerUp	Configure how the system should respond if AC Power
Power Control Policy	Last Power State Power Restore	is lost, Reset not required as selected Power policy will
	Unspecified[Default]	be set in BMC when policy is saved.

4.6.5.1 System Event Log



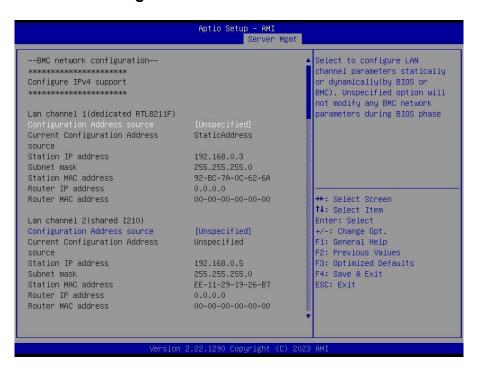
Item	Option	Description	
SEL Components	Enabled[Default]	Change this to enable or disable event logging	
SEL Components	Disabled	for error/progress codes during boot.	
	No[Default]		
Erase SEL	Yes, On next reset	Choose options for erasing SEL.	
	Yes, On every reset		
	Do Nothing[Default]		
When SEL is Full	Erase Immediately	Choose options for reactions to a full SEL.	
	Delete Oldest Record		
	Disabled		
Log EFI Status Codes	Both	Disable the logging of EFI Status Codes or log	
	Error code[Default]	only error code or only progress code or both.	
	Progress code		

4.6.5.2 Bmc self test log



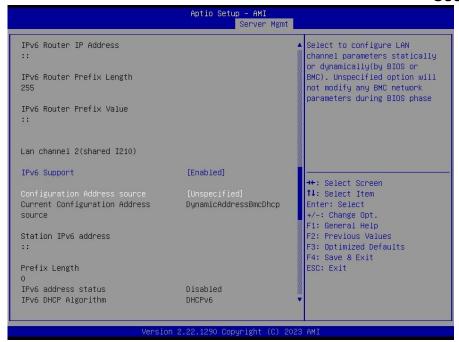
Item	Option	Description
Erase Log	Yes, On every reset[Default] No	Erase Log Options.
When log is full	Clear Log [Default] Do not log any more	Select the action to be taken when log is full.

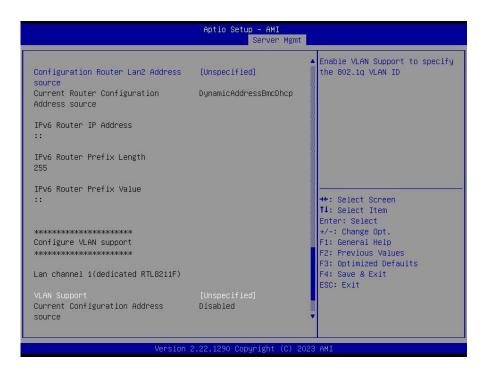
4.6.5.3 BMC network configuration





User's Manual





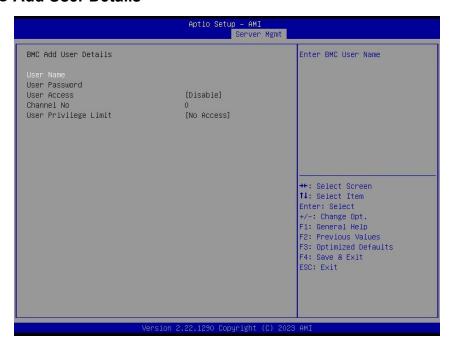


Item	Option	Description
	Unspecified[Default] Static	Select configure LAN channel parameters statically or dynamically(by BIOS or BMC).
Configuration Address source	DynamicBmcDhcp	Unspecified option will not modify any BMC
	DynamicBmcNonDhcp	network parameters during BIOS phase.
IPv6 Support	Enabled[Default] Disabled DynamicBmcDhcp	Enable or Disable LAN1 IPv6 Support.
Configuration Address source	Unspecified[Default] Static DynamicBmcDhcp	Select to configure LAN channel parameters statically or dynamically(by BIOS or BMC). Unspecified option will not modify any BMC network parameters during BIOS phase.
Configuration Router Lan1/2 Address source	Unspecified[Default] Static DynamicBmcDhcp	Select to configure LAN channel parameters statically or dynamically(by BIOS or BMC). Unspecified option will not modify any BMC network parameters during BIOS phase.
VLAN Support Disabled Unspecified[Default]		Enable VLAN Support to specify the 802. 1q VLAN ID.

4.6.5.4 BMC User Settings



4.6.5.4.1 BMC Add User Details



Item	Description	
User Name	Enter BMC User Name.	

4.6.5.4.2 BMC Delete User Details



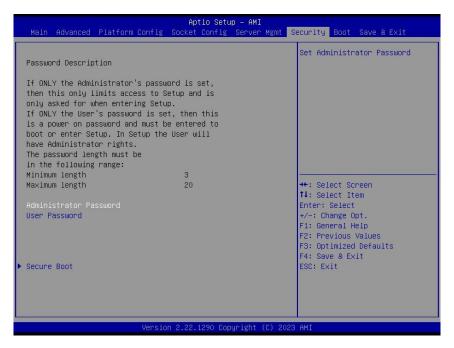
Item	Description	
User Name	Enter BMC User Name.	

4.6.5.4.3 BMC Change User Settings



Item	Description	
User Name	Enter BMC User Name.	

4.6.6 Security



Administrator Password

Set setup Administrator Password

User Password

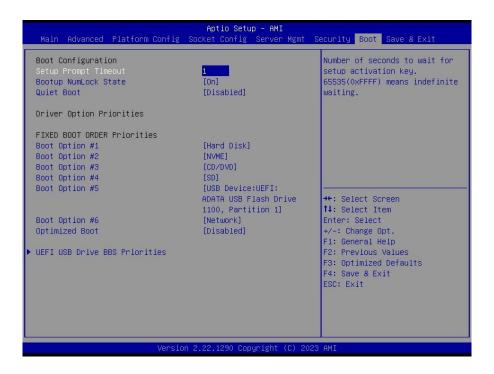
Set User Password

4.6.6.1 Secure Boot



Item	Option	Description
Secure Boot	Disabled Enabled[Default]	Secure Boot feature is Active if Secure Boot is Enabled, Platform Key(PK) is enrolled and the System is in User mode. The mode change requires platform reset.
Secure Boot Mode	Standard[Default] Custom	Secure Boot mode options: Standard or Custom. In Custom mode, Secure Boot Policy variables can be configured by a physically present user without full authentication.

4.6.7 Boot

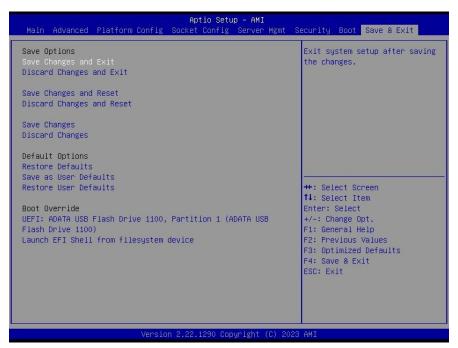


Item	Option	Description
Setup Prompt Timeout Bootup NumLock State	1~ 65535	Set the default timeout before system boot. A
		value of 65535 will disable the timeout completely.
	On[Default]	Completely.
	Off	Select the keyboard NumLock state
Quiet Boot	Disabled [Default] Enabled	Enables or disables Quiet Boot option
Boot Option #1	Hard Disk [Default] NVME	Set the system boot order.
	CD/DVD	
	SD	
	USB Device	
	Network	
Boot Option #2	Hard Disk	Set the system boot order.
	NVME[Default]	
	CD/DVD	
	SD	
	USB Device	
	Network	

User's Manual

	1	
Boot Option #3	Hard Disk NVME	
		Set the system boot order.
	CD/DVD[Default]	
	SD	
	USB Device	
	Network	
	Hard Disk	
	NVME	
Boot Option #4	CD/DVD	Set the system boot order.
	SD[Default]	
	USB Device	
	Network	
Boot Option #5	Hard Disk	
	NVME	Set the system boot order.
	CD/DVD	
	SD	
	USB Device[Default]	
	Network	
	Hard Disk	Set the system boot order.
Boot Option #6	NVME	
	CD/DVD	
	SD	
	USB Device	
	Network[Default]	
Optimized Boot		Enables or disables Optimized Boot. Enabling
		Optimized Boot will disable Csm support and
	Disabled[Default]	disable connecting Network devices to decrease
	Enabled	boot time. While disabling Optimized Boot, make
		sure to restore Csm Support option to previous
		value before enabling Optimized Boot.

4.6.8 Save and exit



4.6.8.1 Save Changes and Exit

Use the save changes and reset option to save the changes made to the BIOS options and to exit the BIOS configuration setup program.

4.6.8.2 Discard Changes and Exit

Use the Discard changes and Exit option to exit the system without saving the changes made to the BIOS configuration setup program.

4.6.8.3 Save Changes and Reset

Reset the system after saving the changes.

4.6.8.4 Discard Changes and Reset

Any changes made to BIOS settings during this session of the BIOS setup program are discarded. The setup program then exits and reboots the controller.

4.6.8.5 Save Changes

Changes made to BIOS settings during this session are committed to NVRAM. The setup program remains active, allowing further changes.

4.6.8.6 Discard Changes

Any changes made to BIOS settings during this session of the BIOS setup program are discarded. The BIOS setup continues to be active.

4.6.8.7 Restore Defaults

This option restores all BIOS settings to the factory default. This option is useful if the controller exhibits unpredictable behavior due to an incorrect or inappropriate BIOS setting.

4.6.8.8 Save as User Defaults

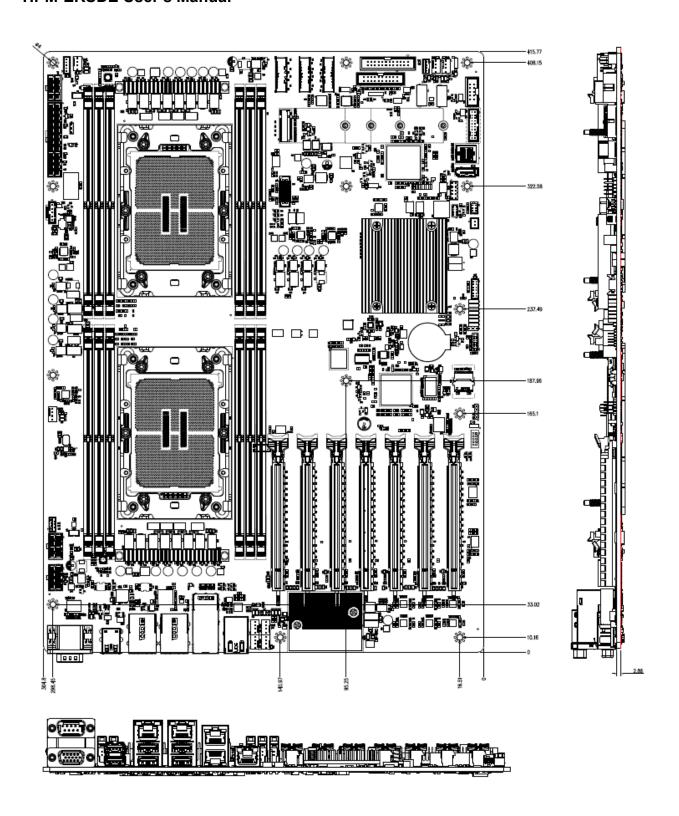
This option saves a copy of the current BIOS settings as the User Defaults. This option is useful for preserving custom BIOS setup configurations.

4.6.8.9 Restore User Defaults

This option restores all BIOS settings to the user defaults. This option is useful for restoring previously preserved custom BIOS setup configurations.

122 HPM-ERSDE User's Manual

5. Mechanical Drawing



Unit: mm

6. Maintenance & Troubleshooting

System Maintenance Introduction

If the components of the product fail they must be replaced.

Please contact the system reseller or vendor to purchase the replacement parts. Please follow the safety precautions outlined in the sections that follow

General Safety Precautions

Please ensure the following safety precautions are adhered to at all times.

- 1. Follow the electrostatic precautions outlined below whenever the device is opened.
- 2. Make sure the power is turned off and the power cord is disconnected whenever the product is being installed, moved or modified.
- 3. To prevent the risk of electric shock, make sure power cord is unplugged from wall socket. To fully disengage the power to the unit, please disconnect the power cord from the AC outlet. Refer servicing to qualified service personnel. The AC outlet shall be readily available and accessible.
- 4. Do not apply voltage levels that exceed the specified voltage range. Doing so may cause fire and/or an electrical shock. Use a power cord that matches the voltage of the power outlet, which has been approved and complies with the safety standard of your particular country.
- 5. Electric shocks can occur if the product chassis is opened when it is running. To avoid risk of electric shock, this device must only be connected to a supply mains with protective earth.
- 6. Do not drop or insert any objects into the ventilation openings of the product.
- 7. If considerable amounts of dust, water, or fluids enter the device, turn off the power supply immediately, unplug the power cord, and contact your dealer or the nearest service center.
- 8. This equipment is not suitable for use in locations where children are likely to be present.
- 9. DO NOT:
- Drop the device.
- In a site where the ambient temperature exceeds the rated temperature.

Anti-Static Precautions

WARNING:

Failure to take ESD precautions during the installation of the product may result in permanent damage to the product and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the product. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the product is opened and any of the electrical components are handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging any electrical component.
- Self-grounding: Before handling any electrical component, touch any grounded conducting material. During the time the electrical component is handled, frequently touch any conducting materials that are connected to the ground.
- Use an anti-static pad: When configuring or working with an electrical component,
 place it on an anti-static pad. This reduces the possibility of ESD damage.
- Only handle the edges of the electrical component. When handling the electrical component, hold the electrical component by its edges. Please ensure the following safety precautions are adhered to at all times.

Maintenance and Cleaning

When maintaining or cleaning the product, please follow the guidelines below.

WARNING:

- For safety reasons, turn-off the power and unplug the PC before cleaning.
- If you dropped any material or liquid such as water onto the PC when cleaning, unplug
 the power cable immediately and contact your dealer or the nearest service center.
 Always make sure your hands are dry when unplugging the power cable.

Maintenance and Cleaning

Prior to cleaning any part or component of the product, please read the details below.

- Never spray or squirt liquids directly onto any other components.
- The interior of the device does not require cleaning. Keep fluids away from the device interior.
- Be cautious of all small removable components when vacuuming the device.
- Never drop any objects or liquids through the openings of the device.
- Be cautious of any possible allergic reactions to solvents or chemicals used when cleaning the device.
- Avoid eating, drinking and smoking within vicinity of the device.

Basic Troubleshooting

PEI Beep Codes

# of Beeps	Description
1	Memory not Installed
2	Recovery started
3	Typically for development use.
	The beep code is generated when DXEIPL PPI or DXE Core is not found.
4	Recovery failed
4	S3 Resume failed
7	Typically for development use.
	The beep code is generated when platform cannot be reset because reset
	PPI is not available.

DXE Beep Codes

# of Beeps	Description
1	Invalid password
	Typically for development use.
4	The beep code is generated when some of the Architectural Protocols are
	not available.
5	No Console Input or Output Devices are found
5	No Console Input Devices are found
6	Flash update is failed
	Typically for development use.
7	The beep code is generated when platform cannot be reset because reset
	protocol is not available.
8	Platform PCI resource requirements cannot be met

